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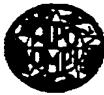
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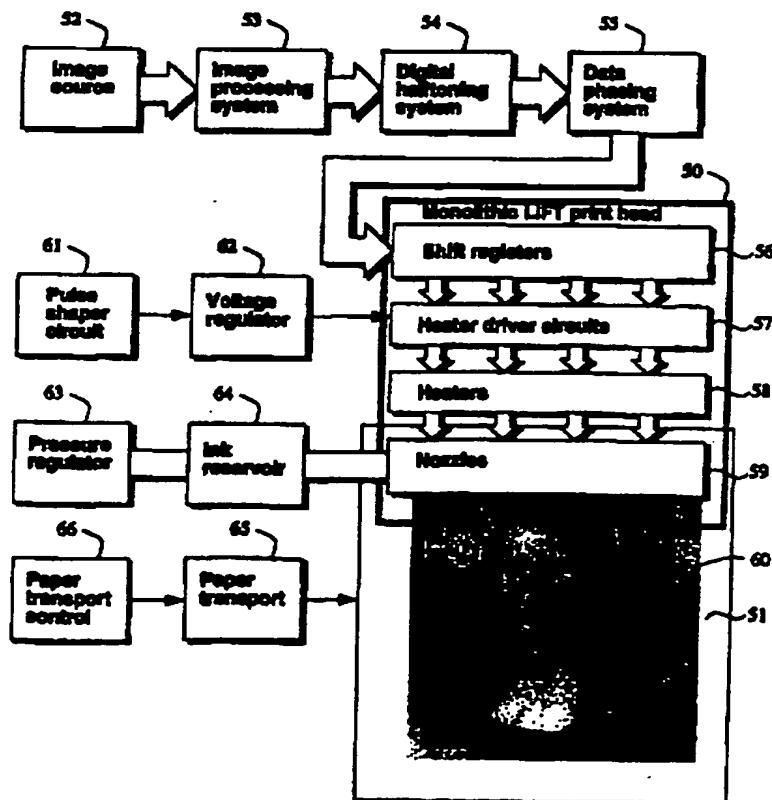
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(54) Title: BLOCK FAULT TOLERANCE IN INTEGRATED PRINTING HEADS

(57) Abstract

Single faults in shift registers incorporated on monolithic printing heads can render inoperable large numbers of printing actuators, as data will either be stuck high or stuck low for subsequent shift register and actuator stages. This can reduce the effectiveness of other means of fault tolerance, and increase the device sensitivity to faults in individual, normally redundant, actuators. A printing head is disclosed which provides block fault tolerance in the shift registers, limiting the effect of shift register fabrication faults to small numbers of redundant actuators. This allows a high probability of defect correction by other forms of fault tolerance integrated on the chip, thereby increasing overall device yield.



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BLOCK FAULT TOLERANCE IN INTEGRATED PRINTING HEADS

Field of the Invention

The present invention is in the field of computer controlled printing devices. In particular, the field is fault tolerance for drop on demand (DOD) 5 printing systems.

Background of the Invention

Many different types of digitally controlled printing systems have been invented, and many types are currently in production. These printing systems use a variety of actuation mechanisms, a variety of marking materials, and a variety 10 of recording media. Examples of digital printing systems in current use include: laser electrophotographic printers; LED electrophotographic printers; dot matrix impact printers; thermal paper printers; film recorders; thermal wax printers; dye diffusion thermal transfer printers; and ink jet printers. However, at present, such electronic printing systems have not significantly replaced mechanical printing 15 presses, even though this conventional method requires very expensive setup and is seldom commercially viable unless a few thousand copies of a particular page are to be printed. Thus, there is a need for improved digitally controlled printing systems, for example, being able to produce high quality color images at a high-speed and low cost, using standard paper.

20 Inkjet printing has become recognized as a prominent contender in the digitally controlled, electronic printing arena because, e.g., of its non-impact, low-noise characteristics, its use of plain paper and its avoidance of toner transfers and fixing.

Many types of ink jet printing mechanisms have been invented. 25 These can be categorized as either continuous ink jet (CIJ) or drop on demand (DOD) ink jet. Continuous ink jet printing dates back to at least 1929: Hansell, US Pat. No. 1,941,001.

Sweet et al US Pat. No. 3,373,437, 1967, discloses an array of continuous ink jet nozzles where ink drops to be printed are selectively charged and

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deflected towards the recording medium. This technique is known as binary deflection CIJ, and is used by several manufacturers, including Elmjet and Scitex.

Hertz et al US Pat. No. 3,416,153, 1966, discloses a method of achieving variable optical density of printed spots in CIJ printing using the 5 electrostatic dispersion of a charged drop stream to modulate the number of droplets which pass through a small aperture. This technique is used in ink jet printers manufactured by Iris Graphics.

Kyser et al US Pat. No. 3,946,398, 1970, discloses a DOD ink jet printer which applies a high voltage to a piezoelectric crystal, causing the crystal to 10 bend, applying pressure on an ink reservoir and jetting drops on demand. Many types of piezoelectric drop on demand printers have subsequently been invented, which utilize piezoelectric crystals in bend mode, push mode, shear mode, and squeeze mode. Piezoelectric DOD printers have achieved commercial success using hot melt inks (for example, Tektronix and Dataproducts printers), and at image 15 resolutions up to 720 dpi for home and office printers (Seiko Epson). Piezoelectric DOD printers have an advantage in being able to use a wide range of inks. However, piezoelectric printing mechanisms usually require complex high voltage drive circuitry and bulky piezoelectric crystal arrays, which are disadvantageous in regard to manufacturability and performance.

Endo et al GB Pat. No. 2,007,162, 1979, discloses an electrothermal DOD ink jet printer which applies a power pulse to an electrothermal transducer (heater) which is in thermal contact with ink in a nozzle. The heater rapidly heats water based ink to a high temperature, whereupon a small quantity of ink rapidly evaporates, forming a bubble. The formation of these bubbles results in a pressure 25 wave which cause drops of ink to be ejected from small apertures along the edge of the heater substrate. This technology is known as Bubblejet™ (trademark of Canon K.K. of Japan), and is used in a wide range of printing systems from Canon, Xerox, and other manufacturers.

Vaught et al US Pat. No. 4,490,728, 1982, discloses an 30 electrothermal drop ejection system which also operates by bubble formation. In

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this system, drops are ejected in a direction normal to the plane of the heater substrate, through nozzles formed in an aperture plate positioned above the heater. This system is known as Thermal Ink Jet, and is manufactured by Hewlett-Packard. In this document, the term Thermal Ink Jet is used to refer to both the Hewlett-Packard system and systems commonly known as Bubblejet™.

5 Thermal Ink Jet printing typically requires approximately 20 μ J over a period of approximately 2 μ s to eject each drop. The 10 Watt active power consumption of each heater is disadvantageous in itself and also necessitates special inks, complicates the driver electronics and precipitates deterioration of heater 10 elements.

Other ink jet printing systems have also been described in technical literature, but are not currently used on a commercial basis. For example, U.S. Patent No. 4,275,290 discloses a system wherein the coincident address of predetermined print head nozzles with heat pulses and hydrostatic pressure, allows 15 ink to flow freely to spacer-separated paper, passing beneath the print head. U.S. Patent Nos. 4,737,803; 4,737,803 and 4,748,458 disclose ink jet recording systems wherein the coincident address of ink in print head nozzles with heat pulses and an electrostatically attractive field cause ejection of ink drops to a print sheet.

20 Each of the above-described inkjet printing systems has advantages and disadvantages. However, there remains a widely recognized need for an improved ink jet printing approach, providing advantages for example, as to cost, speed, quality, reliability, power usage, simplicity of construction and operation, durability and consumables.

25 The printing mechanism is based on a new printing principle called "Liquid Ink Fault Tolerant" (LIFT) Drop on Demand printing. In this document, the term "optical density" refers to a human perceived visual image darkness, and not to spectroscopic optical density $OD = A = \log_{10} (I_0/I)$.

Summary of the invention

My concurrently filed applications, entitled "Liquid Ink Printing Apparatus and System" and "Coincident Drop-Selection, Drop-Separation Printing Method and System" describe new methods and apparatus that afford significant 5 improvements toward overcoming the prior art problems discussed above. Those inventions offer important advantages, e.g., in regard to drop size and placement accuracy, as to printing speeds attainable, as to power usage, as to durability and operative thermal stresses encountered and as to other printer performance characteristics, as well as in regard to manufacturability and the characteristics of 10 useful inks. One important purpose of the present invention is to further enhance the structures and methods described in those applications and thereby contribute to the advancement of printing technology.

Single faults in shift registers incorporated on monolithic printing heads can render inoperable large numbers of printing actuators, as data will either 15 be stuck high or stuck low for subsequent shift register and actuator stages. This can reduce the effectiveness of other means of fault tolerance, and increase the device sensitivity to faults in individual, normally redundant, actuators.

The current invention is a means of limiting the effect of a fault in the shift registers of a printing head to a short length of shift registers. This is 20 achieved by providing redundant shift registers which can be switched in to replace faulty segments of the main shift registers. The shift registers are tested by an external process, and the print head is programmed to replace shift register segments containing faulty nodes with redundant shift registers.

The redundant shift register does not directly control any printing 25 actuators. If used in isolation, this method cannot fully correct a printing head, as printing actuators associated the shift register segment that are replaced will not be activated. However, the effect of a fault in the shift register is limited to a short section of that shift register. This can dramatically reduce the probability that a fault in the shift register cannot be corrected by other fault tolerance mechanisms which 30 provide redundant printing actuators.

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The faults in the shift registers may occur as the result of particulate contamination during the manufacturing process, in which case the inclusion of the block fault tolerance circuitry disclosed herein, in conjunction with other circuits which provide redundant printing actuators, can improve manufacturing yield.

5 The faults may also occur as a failure of the integrated electronic components in the field. In this case, the inclusion of fault tolerance circuitry can improve the operating life of the printing head.

In one aspect, the present invention constitutes in an integrated printing head having a plurality of printing actuators, apparatus for correcting faults
10 in the data transfer to such actuators, said apparatus comprising: (a) a plurality of data transfer devices which, in the absence of faults, transfer data to the printing actuators; (b) at least one redundant data transfer device; (c) means for determining which of the data transfer device contain faults; (d) means for connecting the output of an operational data transfer device which precedes such faulty data transfer
15 device, in terms of data flow, to the input of a corresponding redundant data transfer device; and (e) means for connecting the output of said corresponding redundant data transfer device to the input of the data transfer device which normally is connected to the output of said faulty data transfer device, in terms of data flow.

20 A preferred aspect of the invention is that the data transfer devices are shift registers.

A further preferred aspect of the invention is that the redundant data transfer devices are shift registers.

25 A further preferred aspect of the invention is that the means of determining which of the data transfer devices contain faults is a test which applies data to the inputs of the shift registers and determines if the same data appears at the outputs of the data transfer devices an appropriate number of clock cycles later.

A further preferred aspect of the invention is that the test is applied by an external microprocessor.

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A further preferred aspect of the invention is that the test is applied by an on-chip test circuit.

5 A further preferred aspect of the invention is that the means of connecting the output of an operational data transfer device to the input of a redundant data transfer mechanism is a multiplexer.

A further preferred aspect of the invention is that the multiplexer is programmed by an external microprocessor.

An alternative preferred aspect of the invention is that the multiplexer is programmed by an on-chip test and repair circuit.

10 A further preferred aspect of the invention is that the means of connecting the output of an operational data transfer mechanism to the input of a redundant data transfer device is an integrated fusible link.

15 A further preferred aspect of the invention is that the means of connecting the output of the redundant data transfer device to the input of the data transfer device which normally is connected to the output of the faulty data transfer device in terms of data flow is a multiplexer.

A further preferred aspect of the invention is that the marking means of the integrated printing head is a coincident forces printing head.

20 A further preferred aspect of the invention is that the marking means of the integrated printing head is a thermal drop on demand printing head.

A further alternative preferred aspect of the invention is that the marking means of the integrated printing head is a thermal wax printer actuator.

A further alternative preferred aspect of the invention is that the marking means of the integrated printing head is a dye sublimation printer actuator.

25 A further alternative preferred aspect of the invention is that the marking means of the integrated printing head is a heater element that is part of a heater bar of a thermal paper printer.

Brief Description of the Drawings

30 Figure 1(a) shows a simplified block schematic diagram of one exemplary printing apparatus according to the present invention.

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Figure 1(b) shows a cross section of one variety of nozzle tip in accordance with the invention.

Figures 2(a) to 2(f) show fluid dynamic simulations of drop selection.

5 Figure 3(a) shows a finite element fluid dynamic simulation of a nozzle in operation according to an embodiment of the invention.

Figure 3(b) shows successive meniscus positions during drop selection and separation.

10 Figure 3(c) shows the temperatures at various points during a drop selection cycle.

Figure 3(d) shows measured surface tension versus temperature curves for various ink additives.

Figure 3(e) shows the power pulses which are applied to the nozzle heater to generate the temperature curves of figure 3(c)

15 Figure 4 shows a block schematic diagram of print head drive circuitry for practice of the invention.

Figure 5 shows projected manufacturing yields for an A4 page width color print head embodying features of the invention, with and without fault tolerance.

20 Figure 6 shows a generalized block diagram of a printing system using a print head.

Figure 7 shows a block diagram of a large print head with integrated drive circuitry.

25 Figure 8 shows a block diagram of block fault tolerance in the shift registers of a large print head.

Detailed Description of Preferred Embodiments

In one general aspect, the invention constitutes a drop-on-demand printing mechanism wherein the means of selecting drops to be printed produces a difference in position between selected drops and drops which are not selected, but 30 which is insufficient to cause the ink drops to overcome the ink surface tension and

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separate from the body of ink, and wherein an alternative means is provided to cause separation of the selected drops from the body of ink.

The separation of drop selection means from drop separation means significantly reduces the energy required to select which ink drops are to be printed.

5 Only the drop selection means must be driven by individual signals to each nozzle. The drop separation means can be a field or condition applied simultaneously to all nozzles.

The drop selection means may be chosen from, but is not limited to, the following list:

10 1) Electrothermal reduction of surface tension of pressurized ink
 2) Electrothermal bubble generation, with insufficient bubble volume to cause drop ejection
 3) Piezoelectric, with insufficient volume change to cause drop ejection
 4) Electrostatic attraction with one electrode per nozzle

15 The drop separation means may be chosen from, but is not limited to, the following list:

1) Proximity (recording medium in close proximity to print head)
 2) Proximity with oscillating ink pressure
 3) Electrostatic attraction
 20 4) Magnetic attraction

The table "DOD printing technology targets" shows some desirable characteristics of drop on demand printing technology. The table also lists some methods by which some embodiments described herein, or in other of my related applications, provide improvements over the prior art.

25 *DOD printing technology targets*

Target	Method of achieving improvement over prior art
High speed operation	Practical, low cost, pagewidth printing heads with more than 10,000 nozzles. Monolithic A4 pagewidth print heads can be manufactured using standard 300 mm (12") silicon wafers
High image quality	High resolution (800 dpi is sufficient for most applications), six color process to reduce image noise

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Full color operation	Halftoned process color at 800 dpi using stochastic screening
Ink flexibility	Low operating ink temperature and no requirement for bubble formation
Low power requirements	Low power operation results from drop selection means not being required to fully eject drop
Low cost	Monolithic print head without aperture plate, high manufacturing yield, small number of electrical connections, use of modified existing CMOS manufacturing facilities
High manufacturing yield	Integrated fault tolerance in printing head
High reliability	Integrated fault tolerance in printing head. Elimination of cavitation and kogation. Reduction of thermal shock.
Small number of electrical connections	Shift registers, control logic, and drive circuitry can be integrated on a monolithic print head using standard CMOS processes
Use of existing VLSI manufacturing facilities	CMOS compatibility. This can be achieved because the heater drive power is less than 1% of Thermal Ink Jet heater drive power
Electronic collation	A new page compression system which can achieve 100:1 compression with insignificant image degradation, resulting in a compressed data rate low enough to allow real-time printing of any combination of thousands of pages stored on a low cost magnetic disk drive.

In thermal ink jet (TIJ) and piezoelectric ink jet systems, a drop velocity of approximately 10 meters per second is preferred to ensure that the selected ink drops overcome ink surface tension, separate from the body of the ink, and strike the recording medium. These systems have a very low efficiency of conversion of electrical energy into drop kinetic energy. The efficiency of TIJ systems is approximately 0.02%). This means that the drive circuits for TIJ print heads must switch high currents. The drive circuits for piezoelectric ink jet heads must either switch high voltages, or drive highly capacitive loads. The total power consumption of pagewidth TIJ printheads is also very high. An 800 dpi A4 full color pagewidth TIJ print head printing a four color black image in one second

5 and strike the recording medium. These systems have a very low efficiency of conversion of electrical energy into drop kinetic energy. The efficiency of TIJ systems is approximately 0.02%). This means that the drive circuits for TIJ print heads must switch high currents. The drive circuits for piezoelectric ink jet heads must either switch high voltages, or drive highly capacitive loads. The total power

10 consumption of pagewidth TIJ printheads is also very high. An 800 dpi A4 full color pagewidth TIJ print head printing a four color black image in one second

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would consume approximately 6 kW of electrical power, most of which is converted to waste heat. The difficulties of removal of this amount of heat precludes the production of low cost, high speed, high resolution compact pagewidth TIJ systems.

5 One important feature of embodiments of the invention is a means of significantly reducing the energy required to select which ink drops are to be printed. This is achieved by separating the means for selecting ink drops from the means for ensuring that selected drops separate from the body of ink and form dots on the recording medium. Only the drop selection means must be driven by

10 10 individual signals to each nozzle. The drop separation means can be a field or condition applied simultaneously to all nozzles.

The table "Drop selection means" shows some of the possible means for selecting drops in accordance with the invention. The drop selection means is only required to create sufficient change in the position of selected drops that the drop separation means can discriminate between selected and unselected drops.

15

Drop selection means

Method	Advantage	Limitation
1. Electrothermal reduction of surface tension of pressurized ink	Low temperature increase and low drop selection energy. Can be used with many ink types. Simple fabrication. CMOS drive circuits can be fabricated on same substrate	Requires ink pressure regulating mechanism. Ink surface tension must reduce substantially as temperature increases
2. Electrothermal reduction of ink viscosity, combined with oscillating ink pressure	Medium drop selection energy, suitable for hot melt and oil based inks. Simple fabrication. CMOS drive circuits can be fabricated on same substrate	Requires ink pressure oscillation mechanism. Ink must have a large decrease in viscosity as temperature increases

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3. Electrothermal bubble generation, with insufficient bubble volume to cause drop ejection	Well known technology, simple fabrication, bipolar drive circuits can be fabricated on same substrate	High drop selection energy, requires water based ink, problems with kogation, cavitation, thermal stress
4. Piezoelectric, with insufficient volume change to cause drop ejection	Many types of ink base can be used	High manufacturing cost, incompatible with integrated circuit processes, high drive voltage, mechanical complexity, bulky
5. Electrostatic attraction with one electrode per nozzle	Simple electrode fabrication	Nozzle pitch must be relatively large. Crosstalk between adjacent electric fields. Requires high voltage drive circuits

Other drop selection means may also be used.

The preferred drop selection means for water based inks is method

1: "Electrothermal reduction of surface tension of pressurized ink". This drop selection means provides many advantages over other systems, including; low power operation (approximately 1% of TIJ), compatibility with CMOS VLSI chip fabrication, low voltage operation (approx. 10 V), high nozzle density, low temperature operation, and wide range of suitable ink formulations. The ink must exhibit a reduction in surface tension with increasing temperature.

10 The preferred drop selection means for hot melt or oil based inks is method 2: "Electrothermal reduction of ink viscosity, combined with oscillating ink pressure". This drop selection means is particularly suited for use with inks which exhibit a large reduction of viscosity with increasing temperature, but only a small reduction in surface tension. This occurs particularly with non-polar ink carriers

15 with relatively high molecular weight. This is especially applicable to hot melt and oil based inks.

The table "Drop separation means" shows some of the possible methods for separating selected drops from the body of ink, and ensuring that the selected drops form dots on the printing medium. The drop separation means

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discriminates between selected drops and unselected drops to ensure that unselected drops do not form dots on the printing medium.

Drop separation means

Means	Advantage	Limitation
1. Electrostatic attraction	Can print on rough surfaces, simple implementation	Requires high voltage power supply
2. AC electric field	Higher field strength is possible than electrostatic, operating margins can be increased, ink pressure reduced, and dust accumulation is reduced	Requires high voltage AC power supply synchronized to drop ejection phase. Multiple drop phase operation is difficult
3. Proximity (print head in close proximity to, but not touching, recording medium)	Very small spot sizes can be achieved. Very low power dissipation. High drop position accuracy	Requires print medium to be very close to print head surface, not suitable for rough print media, usually requires transfer roller or belt
4. Transfer Proximity (print head is in close proximity to a transfer roller or belt)	Very small spot sizes can be achieved, very low power dissipation, high accuracy, can print on rough paper	Not compact due to size of transfer roller or transfer belt.
5. Proximity with oscillating ink pressure	Useful for hot melt inks using viscosity reduction drop selection method, reduces possibility of nozzle clogging, can use pigments instead of dyes	Requires print medium to be very close to print head surface, not suitable for rough print media. Requires ink pressure oscillation apparatus
6. Magnetic attraction	Can print on rough surfaces. Low power if permanent magnets are used	Requires uniform high magnetic field strength, requires magnetic ink

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The preferred drop separation means depends upon the intended use. For most applications, method 1: "Electrostatic attraction", or method 2: "AC electric field" are most appropriate. For applications where smooth coated paper or film is used, and very high speed is not essential, method 3: "Proximity" may be

5 appropriate. For high speed, high quality systems, method 4: "Transfer proximity" can be used. Method 6: "Magnetic attraction" is appropriate for portable printing systems where the print medium is too rough for proximity printing, and the high voltages required for electrostatic drop separation are undesirable. There is no clear 'best' drop separation means which is applicable to all circumstances.

10 Further details of various types of printing systems according to the present invention are described in the following Australian patent specifications filed on 12 April 1995, the disclosure of which are hereby incorporated by reference:

'A Liquid ink Fault Tolerant (LIFT) printing mechanism' (Filing no.: PN2308);

15 'Electrothermal drop selection in LIFT printing' (Filing no.: PN2309);
'Drop separation in LIFT printing by print media proximity' (Filing no.: PN2310);
'Drop size adjustment in Proximity LIFT printing by varying head to media distance' (Filing no.: PN2311);

20 'Augmenting Proximity LIFT printing with acoustic ink waves' (Filing no.: PN2312);
'Electrostatic drop separation in LIFT printing' (Filing no.: PN2313);
'Multiple simultaneous drop sizes in Proximity LIFT printing' (Filing no.: PN2321);

25 'Self cooling operation in thermally activated print heads' (Filing no.: PN2322); and
'Thermal Viscosity Reduction LIFT printing' (Filing no.: PN2323).

A simplified schematic diagram of one preferred printing system according to the invention appears in Figure 1(a).

30 An image source 52 may be raster image data from a scanner or computer, or outline image data in the form of a page description language (PDL),

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or other forms of digital image representation. This image data is converted to a pixel-mapped page image by the image processing system 53. This may be a raster image processor (RIP) in the case of PDL image data, or may be pixel image manipulation in the case of raster image data. Continuous tone data produced by the 5 image processing unit 53 is halftoned. Halftoning is performed by the Digital Halftoning unit 54. Halftoned bitmap image data is stored in the image memory 72. Depending upon the printer and system configuration, the image memory 72 may be a full page memory, or a band memory. Heater control circuits 71 read data from the image memory 72 and apply time-varying electrical pulses to the nozzle heaters 10 (103 in figure 1(b)) that are part of the print head 50. These pulses are applied at an appropriate time, and to the appropriate nozzle, so that selected drops will form spots on the recording medium 51 in the appropriate position designated by the data in the image memory 72.

The recording medium 51 is moved relative to the head 50 by a 15 paper transport system 65, which is electronically controlled by a paper transport control system 66, which in turn is controlled by a microcontroller 315. The paper transport system shown in figure 1(a) is schematic only, and many different mechanical configurations are possible. In the case of pagewidth print heads, it is most convenient to move the recording medium 51 past a stationary head 50. 20 However, in the case of scanning print systems, it is usually most convenient to move the head 50 along one axis (the sub-scanning direction) and the recording medium 51 along the orthogonal axis (the main scanning direction), in a relative raster motion. The microcontroller 315 may also control the ink pressure regulator 63 and the heater control circuits 71.

25 For printing using surface tension reduction, ink is contained in an ink reservoir 64 under pressure. In the quiescent state (with no ink drop ejected), the ink pressure is insufficient to overcome the ink surface tension and eject a drop. A constant ink pressure can be achieved by applying pressure to the ink reservoir 64 under the control of an ink pressure regulator 63. Alternatively, for larger printing 30 systems, the ink pressure can be very accurately generated and controlled by

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situating the top surface of the ink in the reservoir 64 an appropriate distance above the head 50. This ink level can be regulated by a simple float valve (not shown).

For printing using viscosity reduction, ink is contained in an ink reservoir 64 under pressure, and the ink pressure is caused to oscillate. The means 5 of producing this oscillation may be a piezoelectric actuator mounted in the ink channels (not shown).

When properly arranged with the drop separation means, selected drops proceed to form spots on the recording medium 51, while unselected drops remain part of the body of ink.

10 The ink is distributed to the back surface of the head 50 by an ink channel device 75. The ink preferably flows through slots and/or holes etched through the silicon substrate of the head 50 to the front surface, where the nozzles and actuators are situated. In the case of thermal selection, the nozzle actuators are electrothermal heaters.

15 In some types of printers according to the invention, an external field 74 is required to ensure that the selected drop separates from the body of the ink and moves towards the recording medium 51. A convenient external field 74 is a constant electric field, as the ink is easily made to be electrically conductive. In this case, the paper guide or platen 67 can be made of electrically conductive material 20 and used as one electrode generating the electric field. The other electrode can be the head 50 itself. Another embodiment uses proximity of the print medium as a means of discriminating between selected drops and unselected drops.

25 For small drop sizes gravitational force on the ink drop is very small; approximately 10^{-4} of the surface tension forces, so gravity can be ignored in most cases. This allows the print head 50 and recording medium 51 to be oriented in any direction in relation to the local gravitational field. This is an important requirement for portable printers.

Figure 1(b) is a detail enlargement of a cross section of a single microscopic nozzle tip embodiment of the invention, fabricated using a modified 30 CMOS process. The nozzle is etched in a substrate 101, which may be silicon,

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glass, metal, or any other suitable material. If substrates which are not semiconductor materials are used, a semiconducting material (such as amorphous silicon) may be deposited on the substrate, and integrated drive transistors and data distribution circuitry may be formed in the surface semiconducting layer. Single crystal silicon (SCS) substrates have several advantages, including:

- 5 1) High performance drive transistors and other circuitry can be fabricated in SCS;
- 10 2) Print heads can be fabricated in existing facilities (fabs) using standard VLSI processing equipment;
- 15 3) SCS has high mechanical strength and rigidity; and
- 4) SCS has a high thermal conductivity.

In this example, the nozzle is of cylindrical form, with the heater 103 forming an annulus. The nozzle tip 104 is formed from silicon dioxide layers 102 deposited during the fabrication of the CMOS drive circuitry. The nozzle tip is 15 passivated with silicon nitride. The protruding nozzle tip controls the contact point of the pressurized ink 100 on the print head surface. The print head surface is also hydrophobized to prevent accidental spread of ink across the front of the print head.

Many other configurations of nozzles are possible, and nozzle embodiments of the invention may vary in shape, dimensions, and materials used.

- 20 20 Monolithic nozzles etched from the substrate upon which the heater and drive electronics are formed have the advantage of not requiring an orifice plate. The elimination of the orifice plate has significant cost savings in manufacture and assembly. Recent methods for eliminating orifice plates include the use of 'vortex' actuators such as those described in Domoto et al US Pat. No. 4,580,158, 1986, assigned to Xerox, and Miller et al US Pat. No. 5,371,527, 1994 assigned to Hewlett-Packard. These, however are complex to actuate, and difficult to fabricate. The preferred method for elimination of orifice plates for print heads of the invention is incorporation of the orifice into the actuator substrate.
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- 30

This type of nozzle may be used for print heads using various techniques for drop separation.

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Operation with Electrostatic Drop Separation

As a first example, operation using thermal reduction of surface tension and electrostatic drop separation is shown in figure 2.

Figure 2 shows the results of energy transport and fluid dynamic simulations performed using FIDAP, a commercial fluid dynamic simulation software package available from Fluid Dynamics Inc., of Illinois, USA. This simulation is of a thermal drop selection nozzle embodiment with a diameter of 8 μm , at an ambient temperature of 30°C. The total energy applied to the heater is 276 nJ, applied as 69 pulses of 4 nJ each. The ink pressure is 10 kPa above ambient air pressure, and the ink viscosity at 30°C is 1.84 cPs. The ink is water based, and includes a sol of 0.1% palmitic acid to achieve an enhanced decrease in surface tension with increasing temperature. A cross section of the nozzle tip from the central axis of the nozzle to a radial distance of 40 μm is shown. Heat flow in the various materials of the nozzle, including silicon, silicon nitride, amorphous silicon dioxide, crystalline silicon dioxide, and water based ink are simulated using the respective densities, heat capacities, and thermal conductivities of the materials. The time step of the simulation is 0.1 μs .

Figure 2(a) shows a quiescent state, just before the heater is actuated. An equilibrium is created whereby no ink escapes the nozzle in the quiescent state by ensuring that the ink pressure plus external electrostatic field is insufficient to overcome the surface tension of the ink at the ambient temperature. In the quiescent state, the meniscus of the ink does not protrude significantly from the print head surface, so the electrostatic field is not significantly concentrated at the meniscus.

Figure 2(b) shows thermal contours at 5°C intervals 5 μs after the start of the heater energizing pulse. When the heater is energized, the ink in contact with the nozzle tip is rapidly heated. The reduction in surface tension causes the heated portion of the meniscus to rapidly expand relative to the cool ink meniscus. This drives a convective flow which rapidly transports this heat over part of the free surface of the ink at the nozzle tip. It is necessary for the heat to be distributed over

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the ink surface, and not just where the ink is in contact with the heater. This is because viscous drag against the solid heater prevents the ink directly in contact with the heater from moving.

Figure 2(c) shows thermal contours at 5°C intervals 10 μ s after the 5 start of the heater energizing pulse. The increase in temperature causes a decrease in surface tension, disturbing the equilibrium of forces. As the entire meniscus has been heated, the ink begins to flow.

Figure 2(d) shows thermal contours at 5°C intervals 20 μ s after the 10 start of the heater energizing pulse. The ink pressure has caused the ink to flow to a new meniscus position, which protrudes from the print head. The electrostatic field becomes concentrated by the protruding conductive ink drop.

Figure 2(e) shows thermal contours at 5°C intervals 30 μ s after the 15 start of the heater energizing pulse, which is also 6 μ s after the end of the heater pulse, as the heater pulse duration is 24 μ s. The nozzle tip has rapidly cooled due to conduction through the oxide layers, and conduction into the flowing ink. The nozzle tip is effectively 'water cooled' by the ink. Electrostatic attraction causes the ink drop to begin to accelerate towards the recording medium. Were the heater pulse significantly shorter (less than 16 μ s in this case) the ink would not accelerate towards the print medium, but would instead return to the nozzle.

Figure 2(f) shows thermal contours at 5°C intervals 26 μ s after the 20 end of the heater pulse. The temperature at the nozzle tip is now less than 5°C above ambient temperature. This causes an increase in surface tension around the nozzle tip. When the rate at which the ink is drawn from the nozzle exceeds the viscously limited rate of ink flow through the nozzle, the ink in the region of the 25 nozzle tip 'necks', and the selected drop separates from the body of ink. The selected drop then travels to the recording medium under the influence of the external electrostatic field. The meniscus of the ink at the nozzle tip then returns to its quiescent position, ready for the next heat pulse to select the next ink drop. One ink drop is selected, separated and forms a spot on the recording medium for each

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heat pulse. As the heat pulses are electrically controlled, drop on demand ink jet operation can be achieved.

Figure 3(a) shows successive meniscus positions during the drop selection cycle at 5 μ s intervals, starting at the beginning of the heater energizing 5 pulse.

Figure 3(b) is a graph of meniscus position versus time, showing the movement of the point at the centre of the meniscus. The heater pulse starts 10 μ s into the simulation.

Figure 3(c) shows the resultant curve of temperature with respect to 10 time at various points in the nozzle. The vertical axis of the graph is temperature, in units of 100°C. The horizontal axis of the graph is time, in units of 10 μ s. The temperature curve shown in figure 3(b) was calculated by FIDAP, using 0.1 μ s time steps. The local ambient temperature is 30 degrees C. Temperature histories at three points are shown:

15 A - Nozzle tip: This shows the temperature history at the circle of contact between the passivation layer, the ink, and air.

B - Meniscus midpoint: This is at a circle on the ink meniscus midway between the nozzle tip and the centre of the meniscus.

20 C - Chip surface: This is at a point on the print head surface 20 μ m from the centre of the nozzle. The temperature only rises a few degrees. This indicates that active circuitry can be located very close to the nozzles without experiencing performance or lifetime degradation due to elevated temperatures.

25 Figure 3(e) shows the power applied to the heater. Optimum operation requires a sharp rise in temperature at the start of the heater pulse, a maintenance of the temperature a little below the boiling point of the ink for the duration of the pulse, and a rapid fall in temperature at the end of the pulse. To achieve this, the average energy applied to the heater is varied over the duration of the pulse. In this case, the variation is achieved by pulse frequency modulation of 0.1 μ s sub-pulses, each with an energy of 4 nJ. The peak power applied to the 30 heater is 40 mW, and the average power over the duration of the heater pulse is

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11.5 mW. The sub-pulse frequency in this case is 5 Mhz. This can readily be varied without significantly affecting the operation of the print head. A higher sub-pulse frequency allows finer control over the power applied to the heater. A sub-pulse frequency of 13.5 Mhz is suitable, as this frequency is also suitable for minimizing 5 the effect of radio frequency interference (RFI).

Inks with a negative temperature coefficient of surface tension

The requirement for the surface tension of the ink to decrease with increasing temperature is not a major restriction, as most pure liquids and many mixtures have this property. Exact equations relating surface tension to temperature 10 for arbitrary liquids are not available. However, the following empirical equation derived by Ramsay and Shields is satisfactory for many liquids:

$$\gamma_T = k \cdot \sqrt{\frac{(T_c - T - 6)}{\left(\frac{Mx}{\rho}\right)^2}}$$

Where γ_T is the surface tension at temperature T , k is a constant, T_c is the critical temperature of the liquid, M is the molar mass of the liquid, x is the 15 degree of association of the liquid, and ρ is the density of the liquid. This equation indicates that the surface tension of most liquids falls to zero as the temperature reaches the critical temperature of the liquid. For most liquids, the critical temperature is substantially above the boiling point at atmospheric pressure, so to achieve an ink with a large change in surface tension with a small change in 20 temperature around a practical ejection temperature, the admixture of surfactants is recommended.

The choice of surfactant is important. For example, water based ink for thermal ink jet printers often contains isopropyl alcohol (2-propanol) to reduce the surface tension and promote rapid drying. Isopropyl alcohol has a boiling point 25 of 82.4°C, lower than that of water. As the temperature rises, the alcohol evaporates faster than the water, decreasing the alcohol concentration and causing an increase in surface tension. A surfactant such as 1-Hexanol (b.p. 158°C) can be

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used to reverse this effect, and achieve a surface tension which decreases slightly with temperature. However, a relatively large decrease in surface tension with temperature is desirable to maximize operating latitude. A surface tension decrease of 20 mN/m over a 30°C temperature range is preferred to achieve large operating margins, while as little as 10mN/m can be used to achieve operation of the print head according to the present invention.

Inks With Large $-\Delta\gamma$

Several methods may be used to achieve a large negative change in surface tension with increasing temperature. Two such methods are:

- 10 1) The ink may contain a low concentration sol of a surfactant which is solid at ambient temperatures, but melts at a threshold temperature. Particle sizes less than 1,000 Å are desirable. Suitable surfactant melting points for a water based ink are between 50°C and 90°C, and preferably between 60°C and 80°C.
- 15 2) The ink may contain an oil/water microemulsion with a phase inversion temperature (PIT) which is above the maximum ambient temperature, but below the boiling point of the ink. For stability, the PIT of the microemulsion is preferably 20°C or more above the maximum non-operating temperature encountered by the ink. A PIT of approximately 80°C is suitable.

Inks with Surfactant Sol

- 20 Inks can be prepared as a sol of small particles of a surfactant which melts in the desired operating temperature range. Examples of such surfactants include carboxylic acids with between 14 and 30 carbon atoms, such as:

Name	Formula	m.p.	Synonym
Tetradecanoic acid	$\text{CH}_3(\text{CH}_2)_{11}\text{COOH}$	58°C	Myristic acid
Hexadecanoic acid	$\text{CH}_3(\text{CH}_2)_{14}\text{COOH}$	63°C	Palmitic acid
Octadecanoic acid	$\text{CH}_3(\text{CH}_2)_{16}\text{COOH}$	71°C	Stearic acid
Eicosanoic acid	$\text{CH}_3(\text{CH}_2)_{18}\text{COOH}$	77°C	Arachidic acid
Docosanoic acid	$\text{CH}_3(\text{CH}_2)_{20}\text{COOH}$	80°C	Behenic acid

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As the melting point of sols with a small particle size is usually slightly less than of the bulk material, it is preferable to choose a carboxylic acid with a melting point slightly above the desired drop selection temperature. A good 5 example is Arachidic acid.

These carboxylic acids are available in high purity and at low cost. The amount of surfactant required is very small, so the cost of adding them to the ink is insignificant. A mixture of carboxylic acids with slightly varying chain lengths can be used to spread the melting points over a range of temperatures. Such 10 mixtures will typically cost less than the pure acid.

It is not necessary to restrict the choice of surfactant to simple unbranched carboxylic acids. Surfactants with branched chains or phenyl groups, or other hydrophobic moieties can be used. It is also not necessary to use a carboxylic acid. Many highly polar moieties are suitable for the hydrophilic end of the 15 surfactant. It is desirable that the polar end be ionizable in water, so that the surface of the surfactant particles can be charged to aid dispersion and prevent flocculation. In the case of carboxylic acids, this can be achieved by adding an alkali such as sodium hydroxide or potassium hydroxide.

Preparation of Inks with Surfactant Sols

20 The surfactant sol can be prepared separately at high concentration, and added to the ink in the required concentration.

An example process for creating the surfactant sol is as follows:

- 1) Add the carboxylic acid to purified water in an oxygen free atmosphere.
- 2) Heat the mixture to above the melting point of the carboxylic acid. The water 25 can be brought to a boil.
- 3) Ultrasonicate the mixture, until the typical size of the carboxylic acid droplets is between 100Å and 1,000Å.
- 4) Allow the mixture to cool.
- 5) Decant the larger particles from the top of the mixture.

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- 6) Add an alkali such as NaOH to ionize the carboxylic acid molecules on the surface of the particles. A pH of approximately 8 is suitable. This step is not absolutely necessary, but helps stabilize the sol.
- 7) Centrifuge the sol. As the density of the carboxylic acid is lower than water, smaller particles will accumulate at the outside of the centrifuge, and larger particles in the centre.
- 5 8) Filter the sol using a microporous filter to eliminate any particles above 5000 Å.
- 9) Add the surfactant sol to the ink preparation. The sol is required only in very 10 dilute concentration.

The ink preparation will also contain either dye(s) or pigment(s), bactericidal agents, agents to enhance the electrical conductivity of the ink if electrostatic drop separation is used, humectants, and other agents as required.

- 15 Anti-foaming agents will generally not be required, as there is no bubble formation during the drop ejection process.

Cationic surfactant sols

- 20 Inks made with anionic surfactant sols are generally unsuitable for use with cationic dyes or pigments. This is because the cationic dye or pigment may precipitate or flocculate with the anionic surfactant. To allow the use of cationic dyes and pigments, a cationic surfactant sol is required. The family of alkylamines is suitable for this purpose.

Various suitable alkylamines are shown in the following table:

Name	Formula	Synonym
Hexadecylamine	$\text{CH}_3(\text{CH}_2)_{12}\text{CH}_2\text{NH}_2$	Palmityl amine
Octadecylamine	$\text{CH}_3(\text{CH}_2)_{16}\text{CH}_2\text{NH}_2$	Stearyl amine
Eicosylamine	$\text{CH}_3(\text{CH}_2)_{18}\text{CH}_2\text{NH}_2$	Arachidyl amine
Docosylamine	$\text{CH}_3(\text{CH}_2)_{20}\text{CH}_2\text{NH}_2$	Behenyl amine

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The method of preparation of cationic surfactant sols is essentially similar to that of anionic surfactant sols, except that an acid instead of an alkali is used to adjust the pH balance and increase the charge on the surfactant particles. A pH of 6 using HCl is suitable.

5 Microemulsion Based Inks

An alternative means of achieving a large reduction in surface tension as some temperature threshold is to base the ink on a microemulsion. A microemulsion is chosen with a phase inversion temperature (PIT) around the desired ejection threshold temperature. Below the PIT, the microemulsion is oil in water (O/W), and above the PIT the microemulsion is water in oil (W/O). At low temperatures, the surfactant forming the microemulsion prefers a high curvature surface around oil, and at temperatures significantly above the PIT, the surfactant prefers a high curvature surface around water. At temperatures close to the PIT, the microemulsion forms a continuous 'sponge' of topologically connected water and oil.

There are two mechanisms whereby this reduces the surface tension. Around the PIT, the surfactant prefers surfaces with very low curvature. As a result, surfactant molecules migrate to the ink/air interface, which has a curvature which is much less than the curvature of the oil emulsion. This lowers the surface tension of the water. Above the phase inversion temperature, the microemulsion changes from O/W to W/O, and therefore the ink/air interface changes from water/air to oil/air. The oil/air interface has a lower surface tension.

There is a wide range of possibilities for the preparation of microemulsion based inks.

25 For fast drop ejection, it is preferable to chose a low viscosity oil.

In many instances, water is a suitable polar solvent. However, in some cases different polar solvents may be required. In these cases, polar solvents with a high surface tension should be chosen, so that a large decrease in surface tension is achievable.

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The surfactant can be chosen to result in a phase inversion temperature in the desired range. For example, surfactants of the group poly(oxyethylene)alkylphenyl ether (ethoxylated alkyl phenols, general formula: $C_6H_{2n+1}C_6H_5(CH_2CH_2O)_mOH$) can be used. The hydrophilicity of the surfactant can 5 be increased by increasing m, and the hydrophobicity can be increased by increasing n. Values of m of approximately 10, and n of approximately 8 are suitable.

Low cost commercial preparations are the result of a polymerization of various molar ratios of ethylene oxide and alkyl phenols, and the exact number of oxyethylene groups varies around the chosen mean. These commercial preparations 10 are adequate, and highly pure surfactants with a specific number of oxyethylene groups are not required.

The formula for this surfactant is $C_6H_{17}C_6H_5(CH_2CH_2O)_nOH$ (average n=10).

Synonyms include Octoxynol-10, PEG-10 octyl phenyl ether and 15 POE (10) octyl phenyl ether

The HLB is 13.6, the melting point is 7°C, and the cloud point is 65°C.

Commercial preparations of this surfactant are available under various brand names. Suppliers and brand names are listed in the following table:

20

Trade name	Supplier
Akyporox OP100	Chem-Y GmbH
Alkasurf OP-10	Rhone-Poulenc Surfactants and Specialties
Dehydrophen POP 10	Pulcra SA
Hyonic OP-10	Henkel Corp.
Iconol OP-10	BASF Corp.
Igepal O	Rhone-Poulenc France
Macol OP-10	PPG Industries
Malorphen 810	Huls AG
Nikkol OP-10	Nikko Chem. Co. Ltd.
Renex 750	ICI Americas Inc.

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Rexol 45/10	Hart Chemical Ltd.
Synperonic OP10	ICI PLC
Teric X10	ICI Australia

These are available in large volumes at low cost (less than one dollar per pound in quantity), and so contribute less than 10 cents per liter to prepared microemulsion ink with a 5% surfactant concentration.

5 Other suitable ethoxylated alkyl phenols include those listed in the following table:

Trivial name	Formula	HLB	Cloud point
Nonoxynol-9	$C_{12}H_{25}C_6H_4(CH_2CH_2O)_{10}OH$	13	54°C
Nonoxynol-10	$C_{12}H_{25}C_6H_4(CH_2CH_2O)_{11}OH$	13.2	62°C
Nonoxynol-11	$C_{12}H_{25}C_6H_4(CH_2CH_2O)_{12}OH$	13.8	72°C
Nonoxynol-12	$C_{12}H_{25}C_6H_4(CH_2CH_2O)_{13}OH$	14.5	81°C
Octoxynol-9	$C_{12}H_{25}C_6H_4(CH_2CH_2O)_{9}OH$	12.1	61°C
Octoxynol-10	$C_{12}H_{25}C_6H_4(CH_2CH_2O)_{10}OH$	13.6	65°C
Octoxynol-12	$C_{12}H_{25}C_6H_4(CH_2CH_2O)_{12}OH$	14.6	88°C
Dodoxynol-10	$C_{12}H_{25}C_6H_4(CH_2CH_2O)_{10}OH$	12.6	42°C
Dodoxynol-11	$C_{12}H_{25}C_6H_4(CH_2CH_2O)_{11}OH$	13.5	56°C
Dodoxynol-14	$C_{12}H_{25}C_6H_4(CH_2CH_2O)_{14}OH$	14.5	87°C

10 Microemulsion based inks have advantages other than surface tension control:

- 1) Microemulsions are thermodynamically stable, and will not separate. Therefore, the storage time can be very long. This is especially significant for office and portable printers, which may be used sporadically.
- 2) The microemulsion will form spontaneously with a particular drop size, and does not require extensive stirring, centrifuging, or filtering to ensure a particular range of emulsified oil drop sizes.
- 3) The amount of oil contained in the ink can be quite high, so dyes which are soluble in oil or soluble in water, or both, can be used. It is also possible to use

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a mixture of dyes, one soluble in water, and the other soluble in oil, to obtain specific colors.

- 4) Oil miscible pigments are prevented from flocculating, as they are trapped in the oil microdroplets.
- 5) The use of a microemulsion can reduce the mixing of different dye colors on the surface of the print medium.
- 6) The viscosity of microemulsions is very low.
- 7) The requirement for humectants can be reduced or eliminated.

Dyes and pigments in microemulsion based inks

10 Oil in water mixtures can have high oil contents - as high as 40% - and still form O/W microemulsions. This allows a high dye or pigment loading.

Mixtures of dyes and pigments can be used. An example of a microemulsion based ink mixture with both dye and pigment is as follows:

- 15 1) 70% water
- 2) 5% water soluble dye
- 3) 5% surfactant
- 4) 10% oil
- 5) 10% oil miscible pigment

20 The following table shows the nine basic combinations of colorants in the oil and water phases of the microemulsion that may be used.

Combination	Colorant in water phase	Colorant in oil phase
1	none	oil miscible pigment
2	none	oil soluble dye
3	water soluble dye	none
4	water soluble dye	oil miscible pigment
5	water soluble dye	oil soluble dye
6	pigment dispersed in water	none
7	pigment dispersed in water	oil miscible pigment

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8	pigment dispersed in water	oil soluble dye
9	none	none

The ninth combination, with no colorants, is useful for printing transparent coatings, UV ink, and selective gloss highlights.

As many dyes are amphiphilic, large quantities of dyes can also be 5 solubilized in the oil-water boundary layer as this layer has a very large surface area.

It is also possible to have multiple dyes or pigments in each phase, and to have a mixture of dyes and pigments in each phase.

When using multiple dyes or pigments the absorption spectrum of 10 the resultant ink will be the weighted average of the absorption spectra of the different colorants used. This presents two problems:

- 1) The absorption spectrum will tend to become broader, as the absorption peaks of both colorants are averaged. This has a tendency to 'muddy' the colors. To obtain brilliant color, careful choice of dyes and pigments based on their absorption spectra, not just their human-perceptible color, needs to be made.
- 15 2) The color of the ink may be different on different substrates. If a dye and a pigment are used in combination, the color of the dye will tend to have a smaller contribution to the printed ink color on more absorptive papers, as the dye will be absorbed into the paper, while the pigment will tend to 'sit on top' of the paper. This may be used as an advantage in some circumstances.

20 Surfactants with a Krafft point in the drop selection temperature range

For ionic surfactants there is a temperature (the Krafft point) below which the solubility is quite low, and the solution contains essentially no micelles. Above the Krafft temperature micelle formation becomes possible and there is a rapid increase in solubility of the surfactant. If the critical micelle concentration 25 (CMC) exceeds the solubility of a surfactant at a particular temperature, then the minimum surface tension will be achieved at the point of maximum solubility, rather than at the CMC. Surfactants are usually much less effective below the Krafft point.

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This factor can be used to achieve an increased reduction in surface tension with increasing temperature. At ambient temperatures, only a portion of the surfactant is in solution. When the nozzle heater is turned on, the temperature rises, and more of the surfactant goes into solution, decreasing the surface tension.

5 A surfactant should be chosen with a Krafft point which is near the top of the range of temperatures to which the ink is raised. This gives a maximum margin between the concentration of surfactant in solution at ambient temperatures, and the concentration of surfactant in solution at the drop selection temperature.

10 The concentration of surfactant should be approximately equal to the CMC at the Krafft point. In this manner, the surface tension is reduced to the maximum amount at elevated temperatures, and is reduced to a minimum amount at ambient temperatures.

The following table shows some commercially available surfactants with Krafft points in the desired range.

15

Formula	Krafft point
$C_{12}H_{23}SO_4Na^+$	57°C
$C_{12}H_{27}SO_4Na^+$	70°C
$C_{14}H_{33}SO_4Na^+$	45°C
$Na^+O_4S(CH_2)_{10}SO_4Na^+$	44.9°C
$K^+O_4S(CH_2)_{16}SO_4K^+$	55°C
$C_{16}H_{33}CH(CH_2)C_6H_5SO_4Na^+$	60.8°C

Surfactants with a cloud point in the drop selection temperature range

Non-ionic surfactants using polyoxyethylene (POE) chains can be used to create an ink where the surface tension falls with increasing temperature. At low temperatures, the POE chain is hydrophilic, and maintains the surfactant in solution. As the temperature increases, the structured water around the POE section of the molecule is disrupted, and the POE section becomes hydrophobic. The surfactant is increasingly rejected by the water at higher temperatures, resulting in increasing concentration of surfactant at the air/ink interface, thereby lowering

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surface tension. The temperature at which the POE section of a nonionic surfactant becomes hydrophilic is related to the cloud point of that surfactant. POE chains by themselves are not particularly suitable, as the cloud point is generally above 100°C

Polyoxypropylene (POP) can be combined with POE in POE/POP
5 block copolymers to lower the cloud point of POE chains without introducing a strong hydrophobicity at low temperatures.

Two main configurations of symmetrical POE/POP block copolymers are available. These are:

- 1) Surfactants with POE segments at the ends of the molecules, and a POP 10 segment in the centre, such as the poloxamer class of surfactants (generically CAS 9003-11-6)
- 2) Surfactants with POP segments at the ends of the molecules, and a POE segment in the centre, such as the meroxapol class of surfactants (generically also CAS 9003-11-6)

15 Some commercially available varieties of poloxamer and meroxapol with a high surface tension at room temperature, combined with a cloud point above 40°C and below 100°C are shown in the following table:

Trivial name	BASF Trade name	Formula	Surface Tension (mN/m)	Cloud point
Meroxapol 105	Pluronic 10R5	HO(CH ₂ CH ₂ CH ₂ O) ₇ - (CH ₂ CH ₂ O) ₁₂ - (CH ₂ CH ₂ CH ₂ O) ₁₂ OH	50.9	69°C
Meroxapol 108	Pluronic 10R8	HO(CH ₂ CH ₂ CH ₂ O) ₇ - (CH ₂ CH ₂ O) ₁₁ - (CH ₂ CH ₂ CH ₂ O) ₁₁ OH	54.1	99°C
Meroxapol 178	Pluronic 17R8	HO(CH ₂ CH ₂ CH ₂ O) ₁₂ - (CH ₂ CH ₂ O) ₁₃ - (CH ₂ CH ₂ CH ₂ O) ₁₂ OH	47.3	81°C
Meroxapol 258	Pluronic 25R8	HO(CH ₂ CH ₂ CH ₂ O) ₁₃ - (CH ₂ CH ₂ O) ₁₆ -	46.1	80°C

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		$(CHCH_2CH_2O)_{11}OH$		
Poloxamer 105	Pluronic L35	$HO(CH_2CH_2O)_{11}-$ $(CHCH_2CH_2O)_{16}-$ $(CH_2CH_2O)_{11}OH$	48.8	77°C
Poloxamer 124	Pluronic L44	$HO(CH_2CH_2O)_{11}-$ $(CHCH_2CH_2O)_{21}-$ $(CH_2CH_2O)_{11}OH$	45.3	65°C

Other varieties of poloxamer and meroxapol can readily be synthesized using well known techniques. Desirable characteristics are a room temperature surface tension which is as high as possible, and a cloud point between 5 40°C and 100°C, and preferably between 60°C and 80°C.

5 Meroxapol $[HO(CHCH_2CH_2O)_x(CH_2CH_2O)_y(CHCH_2CH_2O)_zOH]$ varieties where the average x and z are approximately 4, and the average y is approximately 15 may be suitable.

10 If salts are used to increase the electrical conductivity of the ink, then the effect of this salt on the cloud point of the surfactant should be considered.

The cloud point of POE surfactants is increased by ions that disrupt water structure (such as Γ^-), as this makes more water molecules available to form hydrogen bonds with the POE oxygen lone pairs. The cloud point of POE surfactants is decreased by ions that form water structure (such as Cl^- , OH^-), as 15 fewer water molecules are available to form hydrogen bonds. Bromide ions have relatively little effect. The ink composition can be 'tuned' for a desired temperature range by altering the lengths of POE and POP chains in a block copolymer surfactant, and by changing the choice of salts (e.g Cl^- to Br^- to Γ^-) that are added to increase electrical conductivity. $NaCl$ is likely to be the best choice of salts to 20 increase ink conductivity, due to low cost and non-toxicity. $NaCl$ slightly lowers the cloud point of nonionic surfactants.

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Hot Melt Inks

The ink need not be in a liquid state at room temperature. Solid 'hot melt' inks can be used by heating the printing head and ink reservoir above the melting point of the ink. The hot melt ink must be formulated so that the surface 5 tension of the molten ink decreases with temperature. A decrease of approximately 2 mN/m will be typical of many such preparations using waxes and other substances. However, a reduction in surface tension of approximately 20 mN/m is desirable in order to achieve good operating margins when relying on a reduction in surface tension rather than a reduction in viscosity.

10 The temperature difference between quiescent temperature and drop selection temperature may be greater for a hot melt ink than for a water based ink, as water based inks are constrained by the boiling point of the water.

15 The ink must be liquid at the quiescent temperature. The quiescent temperature should be higher than the highest ambient temperature likely to be encountered by the printed page. The quiescent temperature should also be as low as practical, to reduce the power needed to heat the print head, and to provide a maximum margin between the quiescent and the drop ejection temperatures. A quiescent temperature between 60°C and 90°C is generally suitable, though other temperatures may be used. A drop ejection temperature of between 160°C and 20 200°C is generally suitable.

There are several methods of achieving an enhanced reduction in surface tension with increasing temperature.

- 1) A dispersion of microfine particles of a surfactant with a melting point substantially above the quiescent temperature, but substantially below the drop 25 ejection temperature, can be added to the hot melt ink while in the liquid phase.
- 2) A polar/non-polar microemulsion with a PIT which is preferably at least 20°C above the melting points of both the polar and non-polar compounds.

30 To achieve a large reduction in surface tension with temperature, it is desirable that the hot melt ink carrier have a relatively large surface tension (above 30 mN/m) when at the quiescent temperature. This generally excludes

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alkanes such as waxes. Suitable materials will generally have a strong intermolecular attraction, which may be achieved by multiple hydrogen bonds, for example, polyols, such as Hexanetetrol, which has a melting point of 88°C.

Surface tension reduction of various solutions

5 Figure 3(d) shows the measured effect of temperature on the surface tension of various aqueous preparations containing the following additives:

- 1) 0.1% sol of Stearic Acid
- 2) 0.1% sol of Palmitic acid
- 3) 0.1% solution of Pluronic 10R5 (trade mark of BASF)
- 10 4) 0.1% solution of Pluronic L35 (trade mark of BASF)
- 5) 0.1% solution of Pluronic L44 (trade mark of BASF)

Inks suitable for printing systems of the present invention are described in the following Australian patent specifications, the disclosure of which are hereby incorporated by reference:

15 'Ink composition based on a microemulsion' (Filing no.: PNS223, filed on 6 September 1995);

'Ink composition containing surfactant sol' (Filing no.: PN5224, filed on 6 September 1995);

20 'Ink composition for DOD printers with Krafft point near the drop selection temperature sol' (Filing no.: PN6240, filed on 30 October 1995); and
'Dye and pigment in a microemulsion based ink' (Filing no.: PN6241, filed on 30 October 1995).

Operation Using Reduction of Viscosity

As a second example, operation of an embodiment using thermal 25 reduction of viscosity and proximity drop separation, in combination with hot melt ink, is as follows. Prior to operation of the printer, solid ink is melted in the reservoir 64. The reservoir, ink passage to the print head, ink channels 75, and print head 50 are maintained at a temperature at which the ink 100 is liquid, but exhibits a relatively high viscosity (for example, approximately 100 cP). The Ink 100 is

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retained in the nozzle by the surface tension of the ink. The ink 100 is formulated so that the viscosity of the ink reduces with increasing temperature. The ink pressure oscillates at a frequency which is an integral multiple of the drop ejection frequency from the nozzle. The ink pressure oscillation causes oscillations of the ink meniscus at the nozzle tips, but this oscillation is small due to the high ink viscosity. At the normal operating temperature, these oscillations are of insufficient amplitude to result in drop separation. When the heater 103 is energized, the ink forming the selected drop is heated, causing a reduction in viscosity to a value which is preferably less than 5 cP. The reduced viscosity results in the ink meniscus moving further during the high pressure part of the ink pressure cycle. The recording medium 51 is arranged sufficiently close to the print head 50 so that the selected drops contact the recording medium 51, but sufficiently far away that the unselected drops do not contact the recording medium 51. Upon contact with the recording medium 51, part of the selected drop freezes, and attaches to the recording medium.

As the ink pressure falls, ink begins to move back into the nozzle. The body of ink separates from the ink which is frozen onto the recording medium. The meniscus of the ink 100 at the nozzle tip then returns to low amplitude oscillation. The viscosity of the ink increases to its quiescent level as remaining heat is dissipated to the bulk ink and print head. One ink drop is selected, separated and forms a spot on the recording medium 51 for each heat pulse. As the heat pulses are electrically controlled, drop on demand ink jet operation can be achieved.

Manufacturing of Print Heads

Manufacturing processes for monolithic print heads in accordance with the present invention are described in the following Australian patent specifications filed on 12 April 1995, the disclosure of which are hereby incorporated by reference:

- 'A monolithic LIFT printing head' (Filing no.: PN2301);
- 'A manufacturing process for monolithic LIFT printing heads' (Filing no.: PN2302);
- 30 'A self-aligned heater design for LIFT print heads' (Filing no.: PN2303);

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'Integrated four color LIFT print heads' (Filing no.: PN2304);
'Power requirement reduction in monolithic LIFT printing heads' (Filing no.: PN2305);
5 'A manufacturing process for monolithic LIFT print heads using anisotropic wet etching' (Filing no.: PN2306);
'Nozzle placement in monolithic drop-on-demand print heads' (Filing no.: PN2307);
'Heater structure for monolithic LIFT print heads' (Filing no.: PN2346);
10 'Power supply connection for monolithic LIFT print heads' (Filing no.: PN2347);
'External connections for Proximity LIFT print heads' (Filing no.: PN2348); and
'A self-aligned manufacturing process for monolithic LIFT print heads'
(Filing no.: PN2349); and
15 'CMOS process compatible fabrication of LIFT print heads' (Filing no.: PN5222, 6 September 1995).
'A manufacturing process for LIFT print heads with nozzle rim heaters'
(Filing no.: PN6238, 30 October 1995);
20 'A modular LIFT print head' (Filing no.: PN6237, 30 October 1995);
'Method of increasing packing density of printing nozzles' (Filing no.: PN6236, 30 October 1995); and
'Nozzle dispersion for reduced electrostatic interaction between simultaneously printed droplets' (Filing no.: PN6239, 30 October 1995).

Control of Print Heads

25 Means of providing page image data and controlling heater temperature in print heads of the present invention is described in the following Australian patent specifications filed on 12 April 1995, the disclosure of which are hereby incorporated by reference:
'Integrated drive circuitry in LIFT print heads' (Filing no.: PN2295);

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'A nozzle clearing procedure for Liquid Ink Fault Tolerant (LIFT) printing' (Filing no.: PN2294);

'Heater power compensation for temperature in LIFT printing systems' (Filing no.: PN2314);

5 'Heater power compensation for thermal lag in LIFT printing systems' (Filing no.: PN2315);

'Heater power compensation for print density in LIFT printing systems' (Filing no.: PN2316);

'Accurate control of temperature pulses in printing heads' (Filing no.: 10 PN2317);

'Data distribution in monolithic LIFT print heads' (Filing no.: PN2318);

'Page image and fault tolerance routing device for LIFT printing systems' (Filing no.: PN2319); and

15 'A removable pressurized liquid ink cartridge for LIFT printers' (Filing no.: PN2320).

Image Processing for Print Heads

An objective of printing systems according to the invention is to attain a print quality which is equal to that which people are accustomed to in quality color publications printed using offset printing. This can be achieved using a 20 print resolution of approximately 1,600 dpi. However, 1,600 dpi printing is difficult and expensive to achieve. Similar results can be achieved using 800 dpi printing, with 2 bits per pixel for cyan and magenta, and one bit per pixel for yellow and black. This color model is herein called CC'MM'YK. Where high quality monochrome image printing is also required, two bits per pixel can also be used for 25 black. This color model is herein called CC'MM'YKK'. Color models, halftoning, data compression, and real-time expansion systems suitable for use in systems of this invention and other printing systems are described in the following Australian patent specifications filed on 12 April 1995, the disclosure of which are hereby incorporated by reference:

30 'Four level ink set for bi-level color printing' (Filing no.: PN2339);

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'Compression system for page images' (Filing no.: PN2340);
'Real-time expansion apparatus for compressed page images' (Filing no.: PN2341); and
5 'High capacity compressed document image storage for digital color printers' (Filing no.: PN2342);
'Improving JPEG compression in the presence of text' (Filing no.: PN2343);
'An expansion and halftoning device for compressed page images' (Filing no.: PN2344); and
10 'Improvements in image halftoning' (Filing no.: PN2345).

Applications Using Print Heads According to this Invention

Printing apparatus and methods of this invention are suitable for a wide range of applications, including (but not limited to) the following: color and monochrome office printing, short run digital printing, high speed digital printing, 15 process color printing, spot color printing, offset press supplemental printing, low cost printers using scanning print heads, high speed printers using pagewidth print heads, portable color and monochrome printers, color and monochrome copiers, color and monochrome facsimile machines, combined printer, facsimile and copying machines, label printing, large format plotters, photographic duplication, printers for 20 digital photographic processing, portable printers incorporated into digital 'instant' cameras, video printing, printing of PhotoCD images, portable printers for 'Personal Digital Assistants', wallpaper printing, indoor sign printing, billboard printing, and fabric printing.

Printing systems based on this invention are described in the 25 following Australian patent specifications filed on 12 April 1995, the disclosure of which are hereby incorporated by reference:

'A high speed color office printer with a high capacity digital page image store' (Filing no.: PN2329);
'A short run digital color printer with a high capacity digital page image 30 store' (Filing no.: PN2330);

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'A digital color printing press using LIFT printing technology' (Filing no.: PN2331);

'A modular digital printing press' (Filing no.: PN2332);

'A high speed digital fabric printer' (Filing no.: PN2333);

5 'A color photograph copying system' (Filing no.: PN2334);

'A high speed color photocopier using a LIFT printing system' (Filing no.: PN2335);

'A portable color photocopier using LIFT printing technology' (Filing no.: PN2336);

10 'A photograph processing system using LIFT printing technology' (Filing no.: PN2337);

'A plain paper facsimile machine using a LIFT printing system' (Filing no.: PN2338);

'A PhotoCD system with integrated printer' (Filing no.: PN2293);

15 'A color plotter using LIFT printing technology' (Filing no.: PN2291);

'A notebook computer with integrated LIFT color printing system' (Filing no.: PN2292);

'A portable printer using a LIFT printing system' (Filing no.: PN2300);

'Fax machine with on-line database interrogation and customized magazine

20 printing' (Filing no.: PN2299);

'Miniature portable color printer' (Filing no.: PN2298);

'A color video printer using a LIFT printing system' (Filing no.: PN2296);

and

25 'An integrated printer, copier, scanner, and facsimile using a LIFT printing system' (Filing no.: PN2297)

Compensation of Print Heads for Environmental Conditions

It is desirable that drop on demand printing systems have consistent and predictable ink drop size and position. Unwanted variation in ink drop size and position causes variations in the optical density of the resultant print, reducing the 30 perceived print quality. These variations should be kept to a small proportion of the

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nominal ink drop volume and pixel spacing respectively. Many environmental variables can be compensated to reduce their effect to insignificant levels. Active compensation of some factors can be achieved by varying the power applied to the nozzle heaters.

5 An optimum temperature profile for one print head embodiment involves an instantaneous raising of the active region of the nozzle tip to the ejection temperature, maintenance of this region at the ejection temperature for the duration of the pulse, and instantaneous cooling of the region to the ambient temperature.

10 This optimum is not achievable due to the stored heat capacities and thermal conductivities of the various materials used in the fabrication of the nozzles in accordance with the invention. However, improved performance can be achieved by shaping the power pulse using curves which can be derived by iterative refinement of finite element simulation of the print head. The power applied to the 15 heater can be varied in time by various techniques, including, but not limited to:

- 1) Varying the voltage applied to the heater
- 2) Modulating the width of a series of short pulses (PWM)
- 3) Modulating the frequency of a series of short pulses (PFM)

20 To obtain accurate results, a transient fluid dynamic simulation with free surface modeling is required, as convection in the ink, and ink flow, significantly affect on the temperature achieved with a specific power curve.

25 By the incorporation of appropriate digital circuitry on the print head substrate, it is practical to individually control the power applied to each nozzle. One way to achieve this is by 'broadcasting' a variety of different digital pulse trains across the print head chip, and selecting the appropriate pulse train for each nozzle using multiplexing circuits.

30 An example of the environmental factors which may be compensated for is listed in the table "Compensation for environmental factors". This table identifies which environmental factors are best compensated globally (for the entire print head), per chip (for each chip in a composite multi-chip print head), and per nozzle.

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Compensation for environmental factors

Factor compensated	Scope	Sensing or user control method	Compensation mechanism
Ambient Temperature	Global	Temperature sensor mounted on print head	Power supply voltage or global PFM patterns
Power supply voltage fluctuation with number of active nozzles	Global	Predictive active nozzle count based on print data	Power supply voltage or global PFM patterns
Local heat build-up with successive nozzle actuation	Per nozzle	Predictive active nozzle count based on print data	Selection of appropriate PFM pattern for each printed drop
Drop size control for multiple bits per pixel	Per nozzle	Image data	Selection of appropriate PFM pattern for each printed drop
Nozzle geometry variations between wafers	Per chip	Factory measurement, datafile supplied with print head	Global PFM patterns per print head chip
Heater resistivity variations between wafers	Per chip	Factory measurement, datafile supplied with print head	Global PFM patterns per print head chip
User image intensity adjustment	Global	User selection	Power supply voltage, electrostatic acceleration voltage, or ink pressure
Ink surface tension reduction method and threshold temperature	Global	Ink cartridge sensor or user selection	Global PFM patterns
Ink viscosity	Global	Ink cartridge sensor or user selection	Global PFM patterns and/or clock rate
Ink dye or pigment concentration	Global	Ink cartridge sensor or user selection	Global PFM patterns
Ink response time	Global	Ink cartridge sensor or user selection	Global PFM patterns

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Most applications will not require compensation for all of these variables. Some variables have a minor effect, and compensation is only necessary where very high image quality is required.

Print head drive circuits

5 Figure 4 is a block schematic diagram showing electronic operation of an example head driver circuit in accordance with this invention. This control circuit uses analog modulation of the power supply voltage applied to the print head to achieve heater power modulation, and does not have individual control of the power applied to each nozzle. Figure 4 shows a block diagram for a system using an
10 800 dpi pagewidth print head which prints process color using the CC'MM'YK color model. The print head 50 has a total of 79,488 nozzles, with 39,744 main nozzles and 39,744 redundant nozzles. The main and redundant nozzles are divided into six colors, and each color is divided into 8 drive phases. Each drive phase has a shift register which converts the serial data from a head control ASIC 400 into
15 parallel data for enabling heater drive circuits. There is a total of 96 shift registers, each providing data for 828 nozzles. Each shift register is composed of 828 shift register stages 217, the outputs of which are logically anded with phase enable signal by a nand gate 215. The output of the nand gate 215 drives an inverting buffer 216, which in turn controls the drive transistor 201. The drive transistor 201
20 actuates the electrothermal heater 200, which may be a heater 103 as shown in figure 1(b). To maintain the shifted data valid during the enable pulse, the clock to the shift register is stopped the enable pulse is active by a clock stopper 218, which is shown as a single gate for clarity, but is preferably any of a range of well known glitch free clock control circuits. Stopping the clock of the shift register removes
25 the requirement for a parallel data latch in the print head, but adds some complexity to the control circuits in the Head Control ASIC 400. Data is routed to either the main nozzles or the redundant nozzles by the data router 219 depending on the state of the appropriate signal of the fault status bus.

30 The print head shown in figure 4 is simplified, and does not show various means of improving manufacturing yield, such as block fault tolerance.

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Drive circuits for different configurations of print head can readily be derived from the apparatus disclosed herein.

Digital information representing patterns of dots to be printed on the recording medium is stored in the Page or Band memory 1513, which may be the

5 same as the Image memory 72 in figure 1(a). Data in 32 bit words representing dots of one color is read from the Page or Band memory 1513 using addresses selected by the address mux 417 and control signals generated by the Memory Interface 418. These addresses are generated by Address generators 411, which forms part of the 'Per color circuits' 410, for which there is one for each of the six color components.

10 The addresses are generated based on the positions of the nozzles in relation to the print medium. As the relative position of the nozzles may be different for different print heads, the Address generators 411 are preferably made programmable. The Address generators 411 normally generate the address corresponding to the position of the main nozzles. However, when faulty nozzles are present, locations of

15 blocks of nozzles containing faults can be marked in the Fault Map RAM 412. The Fault Map RAM 412 is read as the page is printed. If the memory indicates a fault in the block of nozzles, the address is altered so that the Address generators 411 generate the address corresponding to the position of the redundant nozzles. Data read from the Page or Band memory 1513 is latched by the latch 413 and converted

20 to four sequential bytes by the multiplexer 414. Timing of these bytes is adjusted to match that of data representing other colors by the FIFO 415. This data is then buffered by the buffer 430 to form the 48 bit main data bus to the print head 50. The data is buffered as the print head may be located a relatively long distance from the head control ASIC. Data from the Fault Map RAM 412 also forms the input to

25 the FIFO 416. The timing of this data is matched to the data output of the FIFO 415, and buffered by the buffer 431 to form the fault status bus.

The programmable power supply 320 provides power for the head

30 50. The voltage of the power supply 320 is controlled by the DAC 313, which is part of a RAM and DAC combination (RAMDAC) 316. The RAMDAC 316 contains a dual port RAM 317. The contents of the dual port RAM 317 are

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programmed by the Microcontroller 315. Temperature is compensated by changing the contents of the dual port RAM 317. These values are calculated by the microcontroller 315 based on temperature sensed by a thermal sensor 300. The thermal sensor 300 signal connects to the Analog to Digital Converter (ADC) 311.

5 The ADC 311 is preferably incorporated in the Microcontroller 315.

The Head Control ASIC 400 contains control circuits for thermal lag compensation and print density. Thermal lag compensation requires that the power supply voltage to the head 50 is a rapidly time-varying voltage which is synchronized with the enable pulse for the heater. This is achieved by programming

10 the programmable power supply 320 to produce this voltage. An analog time varying programming voltage is produced by the DAC 313 based upon data read from the dual port RAM 317. The data is read according to an address produced by the counter 403. The counter 403 produces one complete cycle of addresses during the period of one enable pulse. This synchronization is ensured, as the counter 403
15 is clocked by the system clock 408, and the top count of the counter 403 is used to clock the enable counter 404. The count from the enable counter 404 is then decoded by the decoder 405 and buffered by the buffer 432 to produce the enable pulses for the head 50. The counter 403 may include a prescaler if the number of states in the count is less than the number of clock periods in one enable pulse.
20 Sixteen voltage states are adequate to accurately compensate for the heater thermal lag. These sixteen states can be specified by using a four bit connection between the counter 403 and the dual port RAM 317. However, these sixteen states may not be linearly spaced in time. To allow non-linear timing of these states the counter 403 may also include a ROM or other device which causes the counter 403 to count in a
25 non-linear fashion. Alternatively, fewer than sixteen states may be used.

For print density compensation, the printing density is detected by counting the number of pixels to which a drop is to be printed ('on' pixels) in each enable period. The 'on' pixels are counted by the On pixel counters 402. There is one On pixel counter 402 for each of the eight enable phases. The number of enable

30 phases in a print head in accordance with the invention depend upon the specific

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design. Four, eight, and sixteen are convenient numbers, though there is no requirement that the number of enable phases is a power of two. The On Pixel Counters 402 can be composed of combinatorial logic pixel counters 420 which determine how many bits in a nibble of data are on. This number is then 5 accumulated by the adder 421 and accumulator 422. A latch 423 holds the accumulated value valid for the duration of the enable pulse. The multiplexer 401 selects the output of the latch 423 which corresponds to the current enable phase, as determined by the enable counter 404. The output of the multiplexer 401 forms part of the address of the dual port RAM 317. An exact count of the number of 'on' 10 pixels is not necessary, and the most significant four bits of this count are adequate.

Combining the four bits of thermal lag compensation address and the four bits of print density compensation address means that the dual port RAM 317 has an 8 bit address. This means that the dual port RAM 317 contains 256 numbers, which are in a two dimensional array. These two dimensions are time (for thermal 15 lag compensation) and print density. A third dimension - temperature - can be included. As the ambient temperature of the head varies only slowly, the microcontroller 315 has sufficient time to calculate a matrix of 256 numbers compensating for thermal lag and print density at the current temperature. Periodically (for example, a few times a second), the microcontroller senses the 20 current head temperature and calculates this matrix.

The clock to the print head 50 is generated from the system clock 408 by the Head clock generator 407, and buffered by the buffer 406. To facilitate testing of the Head control ASIC, JTAG test circuits 499 may be included.

Comparison with thermal ink jet technology

25 The table "Comparison between Thermal ink jet and Present Invention" compares the aspects of printing in accordance with the present invention with thermal ink jet printing technology.

A direct comparison is made between the present invention and thermal ink jet technology because both are drop on demand systems which operate

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using thermal actuators and liquid ink. Although they may appear similar, the two technologies operate on different principles.

Thermal ink jet printers use the following fundamental operating principle. A thermal impulse caused by electrical resistance heating results in the 5 explosive formation of a bubble in liquid ink. Rapid and consistent bubble formation can be achieved by superheating the ink, so that sufficient heat is transferred to the ink before bubble nucleation is complete. For water based ink, ink temperatures of approximately 280°C to 400°C are required. The bubble formation causes a pressure wave which forces a drop of ink from the aperture with high velocity. The 10 bubble then collapses, drawing ink from the ink reservoir to re-fill the nozzle.

Thermal ink jet printing has been highly successful commercially due to the high nozzle packing density and the use of well established integrated circuit manufacturing techniques. However, thermal ink jet printing technology faces 15 significant technical problems including multi-part precision fabrication, device yield, image resolution, 'pepper' noise, printing speed, drive transistor power, waste power dissipation, satellite drop formation, thermal stress, differential thermal expansion, kogation, cavitation, rectified diffusion, and difficulties in ink formulation.

Printing in accordance with the present invention has many of the 20 advantages of thermal ink jet printing, and completely or substantially eliminates many of the inherent problems of thermal ink jet technology.

Comparison between Thermal ink jet and Present Invention

	Thermal Ink-Jet	Present Invention
Drop selection mechanism	Drop ejected by pressure wave caused by thermally induced bubble	Choice of surface tension or viscosity reduction mechanisms
Drop separation mechanism	Same as drop selection mechanism	Choice of proximity, electrostatic, magnetic, and other methods
Basic ink carrier	Water	Water, microemulsion, alcohol, glycol, or hot melt

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Head construction	Precision assembly of nozzle plate, ink channel, and substrate	Monolithic
Per copy printing cost	Very high due to limited print head life and expensive inks	Can be low due to permanent print heads and wide range of possible inks
Satellite drop formation	Significant problem which degrades image quality	No satellite drop formation
Operating ink temperature	280°C to 400°C (high temperature limits dye use and ink formulation)	Approx. 70°C (depends upon ink formulation)
Peak heater temperature	400°C to 1,000°C (high temperature reduces device life)	Approx. 130°C
Cavitation (heater erosion by bubble collapse)	Serious problem limiting head life	None (no bubbles are formed)
Kogation (coating of heater by ink ash)	Serious problem limiting head life and ink formulation	None (water based ink temperature does not exceed 100°C)
Rectified diffusion (formation of ink bubbles due to pressure cycles)	Serious problem limiting ink formulation	Does not occur as the ink pressure does not go negative
Resonance	Serious problem limiting nozzle design and repetition rate	Very small effect as pressure waves are small
Practical resolution	Approx. 800 dpi max.	Approx. 1,600 dpi max.
Self-cooling operation	No (high energy required)	Yes: printed ink carries away drop selection energy
Drop ejection velocity	High (approx. 10 m/sec)	Low (approx. 1 m/sec)
Crosstalk	Serious problem requiring careful acoustic design, which limits nozzle refill rate.	Low velocities and pressures associated with drop ejection make crosstalk very small.
Operating thermal stress	Serious problem limiting print-head life.	Low: maximum temperature increase approx. 90°C at centre of heater.

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Manufacturing thermal stress	Serious problem limiting print-head size.	Same as standard CMOS manufacturing process.
Drop selection energy	Approx. 20 μ J	Approx. 270 nJ
Heater pulse period	Approx. 2-3 μ s	Approx. 15-30 μ s
Average heater pulse power	Approx. 8 Watts per heater.	Approx. 12 mW per heater. This is more than 500 times less than Thermal Ink-Jet.
Heater pulse voltage	Typically approx. 40V.	Approx. 5 to 10V.
Heater peak pulse current	Typically approx. 200 mA per heater. This requires bipolar or very large MOS drive transistors.	Approx. 4 mA per heater. This allows the use of small MOS drive transistors.
Fault tolerance	Not implemented. Not practical for edge shooter type.	Simple implementation results in better yield and reliability
Constraints on ink composition	Many constraints including kogation, nucleation, etc.	Temperature coefficient of surface tension or viscosity must be negative.
Ink pressure	Atmospheric pressure or less	Approx. 1.1 atm
Integrated drive circuitry	Bipolar circuitry usually required due to high drive current	CMOS, nMOS, or bipolar
Differential thermal expansion	Significant problem for large print heads	Monolithic construction reduces problem
Pagewidth print heads	Major problems with yield, cost, precision construction, head life, and power dissipation	High yield, low cost and long life due to fault tolerance. Self cooling due to low power dissipation.

When fault tolerance is included in a device, standard yield equations cannot be used. Instead, the mechanisms and degree of fault tolerance must be specifically analyzed and included in the yield equation. Figure 5 shows the fault tolerant yield for a full width color A4 print head which includes various forms of fault tolerance, the modeling of which has been included in the yield equation. This graph shows projected yield as a function of both defect density and

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defect clustering. The yield projection shown in figure 5 indicates that thoroughly implemented fault tolerance can increase wafer sort yield from under 1% to more than 90% under identical manufacturing conditions. This can reduce the manufacturing cost by a factor of 100.

5 Fault tolerance approaches in drop-on-demand printing systems are described in the following Australian patent specifications filed on 12 April 1995, the disclosure of which are hereby incorporated by reference:

‘Integrated fault tolerance in printing mechanisms’ (Filing no.: PN2324);

‘Block fault tolerance in integrated printing heads’ (Filing no.: PN2325);

10 ‘Nozzle duplication for fault tolerance in integrated printing heads’ (Filing no.: PN2326);

‘Detection of faulty nozzles in printing heads’ (Filing no.: PN2327); and

‘Fault tolerance in high volume LIFT printing presses’ (Filing no.: PN2328).

15 The Effect of Fault Tolerance on Device Yield

Electronic fabrication processes are inexact, and not all devices are functional after fabrication. The scale of modern electronic devices is so small that contaminants smaller than 1 micron can cause catastrophic device failure. These contaminants may be airborne dust particles which settle on the lithography mask or 20 on the photoresist, causing point defects in the manufacturing process. Pinholes in the resist layer may also cause device defects. The contaminants may also be larger, such as thin residues left by an impure chemical process, or dislodged particles of resist or other parts of the processing environment. Impurities and micro-fractures in the silicon wafer itself may also cause device defects. Process parameters, such as 25 etching times, temperatures, gas densities, plasma excitation energies and so forth, which are not correctly adjusted can cause device failure. There are many other causes of defects in integrated circuit manufacture. The percentage of devices which are operational is known as the yield.

Yield has a direct influence on manufacturing cost. A device with a 30 yield of 5% is effectively ten times more expensive to manufacture than a similar

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device with a manufacturing yield of 50%. The semiconductor manufacturing industry has made significant improvements in device yield by establishing cleaner processing environments, purer substances, more accurate processes, and electronic designs more tolerant of processing variations.

5 Yield Estimation

It is important to know approximately what yield can be expected before beginning manufacture of a new device. This information is used for planning the economics of the device, setting targets for production yield, and finding ways to improve the production process and device.

10 There are three major yield measurements:

- 1) Fab yield: This is the percentage of the wafers which are started on the wafer fabrication line that reach the end of wafer fabrication. Causes for rejection during manufacture include breakage, warping, incorrect processing order, process out of tolerance, and large area contamination. The fab yield Y_{fab} is typically low for a new process. However, with a mature process on an automated fab line, a fab yield of better than 90% can usually be achieved.
- 15 2) Wafer sort yield: This is percentage of die which pass wafer test. Before the wafer is diced, the individual die are tested with a wafer probe. The wafer sort yield Y_{sort} is usually affected primarily by the number of point defects caused by dust and other contaminants per unit area (the defect density, D), and the chip area, A . Only die which pass wafer sort are packaged.
- 20 3) Final test yield: This is the percentage of packaged die which pass final functional and parametric tests. Final test yield Y_{test} is usually 95% or more in a mature process.

25 Total Yield

The total yield Y_{total} is the percentage of functional dice (in this case, print heads) as compared with the number of whole dice on the starting wafers. This is calculated as:

$$Y_{total} = Y_{fab} \times Y_{sort} \times Y_{test}$$

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All three major yield factors must be high to achieve a good total yield.

Wafer Sort Yield

5 In a mature process, it is typically the wafer sort yield which is the most serious limitation on total yield. This is particularly true for large dice. Full page width print heads are large in comparison with typical VLSI circuits. Good wafer sort yield is critical to the cost effective manufacture of print heads.

10 There are several techniques in use for wafer sort yield estimation. An early method assumes that defects are randomly distributed at a specific defect density. The device yield is calculated according to probabilities based on Boltzmann distribution:

$$Y_{sort} = e^{-DA}$$

where Y_{sort} is the wafer sort yield, D is the defect density, and A is the chip area.

15 This method was shown to be generally pessimistic for large size chips, as the defect density is usually not perfectly even. Rather, there is a distribution of defect densities.

20 One of the most widely used yield prediction methods is Murphy's method, which has proven to be a good predictor for LSI and VLSI circuits. Murphy's method approximates the distribution of defect densities, calculating the yield as:

$$Y_{sort} = \left(\frac{1 - e^{-DA}}{DA} \right)^2$$

25 Figure 5 is a graph of wafer sort yield versus defect density for a monolithic full width color A4 print head. This graph compares the non fault-tolerant yield 198 with the fault tolerant yield 199. The non fault tolerant yield is calculated according to Murphy's method. The head is 215 mm long by 5 mm wide.

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It is possible to fabricate such print heads using current technology by using silicon wafers cut axially from the silicon crystal, rather than radial cut wafers.

With a defect density of one defect per square cm, Murphy's method predicts a yield less than 1%. This means that more than 99% of heads fabricated 5 would have to be discarded. This low yield is highly undesirable, as the print head manufacturing cost becomes unacceptably high.

As commercial pressure to introduce larger devices increases, the quality of clean rooms, processes, and raw materials has steadily improved to reduce the defect density. However, single chip devices as large as full width print 10 heads remain uneconomic due to low wafer sort yield.

Defect Clustering

Murphy's method approximates the effect of an uneven distribution of defects. To explicitly model this uneven distribution, a defect clustering factor C can be introduced. The defect clustering factor is a measure of the proportion that 15 defects are clustered (either by area on a wafer, or by wafer), thereby affecting fewer chips. Defect clustering is advantageous for non-fault tolerant designs, but can adversely affect fault tolerance. The yield for a non-fault tolerant device, with explicit modeling for clustering factor, can be calculated as:

$$Y_{sort} = \frac{e^{-DMC} + Ce^{\frac{-DM}{C}}}{C + 1}$$

20 Figure 5 includes a graph of non fault tolerant yield with explicit clustering factor 197. The defect clustering factor is not a controllable parameter in manufacturing, but is a characteristic of the manufacturing process. The clustering factor for manufacturing processes can be expected to be approximately 2, in which case yield projections closely match Murphy's method.

Fault tolerance

A solution to the problem of low yield is to incorporate fault tolerance. Fault tolerance techniques have been used for some time in large memory

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chips and in wafer scale integration (WSI). Fault tolerance usually operates by providing redundancy. If some functional unit of the chip contains a defect, it is replaced by a 'redundant' or spare functional unit. First, the faulty sub-units are determined (usually by external testing), then routing paths to connect redundant sub-units to replace the faulty sub-units are determined. Then the chip is programmed with these new connections. This programming may be achieved by various means, such as laser programming of connections, fused links, anti-fuses, or on-chip configuration registers.

In memory chips and most WSI devices, the physical location of redundant sub-units has no intrinsic relevance. However, in printing heads the redundant sub-unit contains one or more printing actuators. These must have a fixed spatial relationship to the page being printed. In general, it is not effective to replace a faulty actuator with another actuator which is in a different position in the non-scan direction. Such an actuator cannot print a dot in the correct position to replace the faulty actuator. However, it is possible to replace faulty actuators with actuators which are displaced in the scan direction. To ensure that the redundant actuator prints the dot in the same position as the faulty actuator, the data timing to the redundant actuator can be altered to compensate for the displacement in the scan direction.

To allow replacement of all nozzles, there must be a complete set of spare nozzles, which results in 100% redundancy. 100% redundancy is typically not required in memory chips or WSI devices, as a small number of redundant sub-units can be connected to faulty sub-units in many positions. The requirement for 100% redundancy would normally more than double the chip area, dramatically reducing the primary yield before fault tolerance programming.

However, in such print heads, minimum physical dimensions of the head chip are set by the width of the page being printed, the fragility of the print head chip, and manufacturing constraints on fabrication of ink channels which supply ink to the back surface of the chip. The minimum practical size for a full width, full color print head for printing A4 size paper is approximately 215 mm x 5

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mm. This size allows the inclusion of 100% redundancy without increasing chip area, when using 1.5 micron CMOS fabrication technology. Therefore, a high level of fault tolerance can be included without decreasing primary yield.

Yield calculation for fault tolerance

5 Yield projections for wafer sort yield versus defect density for a full width color A4 print head which includes various forms of fault tolerance are shown in Figure 5.

10 This graph shows projected yield as a function of both defect density and defect clustering. Defect clustering models the non-uniform distribution of defects. If a defect occurs at a particular location, the probability of another defect being nearby is typically higher than that implied by the defect density. This is because physical defects tend to cluster, both spatially and temporally. A defect cluster factor of 1 is equivalent to a Boltzmann probability distribution.

15 When fault tolerance is included in a device, standard yield equations cannot be used. Instead, the mechanisms and degree of fault tolerance must be specifically analyzed and included in any equation. The main equation used for this wafer sort yield projection is:

$$Y_{Sort} = Y_{Nozzles} Y_{IR} Y_{Clock} Y_{NFT} Y_{Bus}$$

20 $Y_{Nozzles}$ is the yield from defects in the nozzles and nozzle drive circuits. It models the fault tolerant situation where a fault must occur in both a nozzle or drive circuit and in the matching redundant nozzle or drive circuit before a system fault occurs. It is calculated according to the following equation:

$$Y_{Nozzles} = 1 - (1 - e^{-DN \cdot A_n}) (1 - e^{-DN \cdot C})$$

Where:

25 D is the defect density

N_n is the number of main nozzles [19,840]

A_n is the area of one main nozzle and drive circuit [$8,400 \mu\text{m}^2$]

C is the defect clustering factor

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(Values shown in square brackets [] are specific for the A4 full color
LIFT head with yield projections shown in Figure 5.)

5 Y_{SR} is the yield from defects in the shift register circuits. The shift register circuits include redundant shift registers and data routing multiplexers. A fault in a shift register block will have no system level effect if there is no fault in either the matching redundant shift register, or any one of the nozzles driven by the matching redundant shift register. This case is described by the following equation:

Where:

10
$$Y_{SR} = 1 - \left(1 - e^{-DN_{SR}A_{SR}} \right) \left(1 - e^{-DCL_{SR}(A_{SR} + A_{NR})} \right)$$

N_{SR} is the number of main shift register stages [19,840]

A_{SR} is the area of one shift register stage [$4,200 \mu\text{m}^2$]

L_{SR} is the length of fault tolerant shift register blocks [64]

15 Y_{Clock} is the yield from defects in the fault tolerant clock circuits. This yield is described by the following equation

Where:

$$Y_{Clock} = 1 - \left(1 - e^{-\frac{DN_{Clock}A_{Clock}}{L_{Clock}}} \right) \left(1 - e^{-\frac{DN_{Clock}A_{Clock}}{2}} \right)$$

A_{Clock} is the area of one clock generator [$1,600 \mu\text{m}^2$]

20

Y_{NFT} is the yield from defects in the non fault tolerant input circuits. This does not include input pads, which usually have very low defect densities. This yield is described by the following equation:

Where:

25
$$Y_{NFT} = e^{-D(A_{NFT} + A_{Input})}$$

A_{Input} is the area of non fault tolerant input circuits [$80,000 \mu\text{m}^2$]

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A_{bus} is the area of non fault tolerant multiplexer select controller circuits [1,600,000 μm^2]

Y_{bus} is the yield from defects in the non fault tolerant multiplexer control bus. While this is simply a 9 bit bus on one metal layer, it is not fault tolerant in the current design. The defect density is divided by three because only the top metal layer is defect sensitive. In a two level metal device, a single level of metal usually contributes less than 33% of the chip defects. The multiplexer control bus can be made fault tolerant with a small increase chip complexity. This yield is described by the following equation:

Where:

$$Y_{bus} = e^{-\frac{D}{3} L_{bus} W_{bus}}$$

L_{bus} is the length of the print head [215 mm]

W_{bus} is width of the bus [108 μm]

15

These equations combine to form the following equation for fault tolerant sort yield:

$$Y_{sort} = \left(1 - \left(1 - e^{-DN_x A_x} \right) \left(1 - e^{-DN_y A_y} \right)\right) \\ \left(1 - \left(1 - e^{-DN_{bus} A_{bus}} \right) \left(1 - e^{-DCI_{bus} (A_{bus} + A_y)} \right)\right) \\ \left(1 - \left(1 - e^{-\frac{DN_x A_x}{L_{bus}}} \right) \left(1 - e^{-\frac{DN_y A_y}{L_{bus}}} \right)\right) e^{-D \left(A_{sort} + A_{bus} + \frac{L_{bus} W_{bus}}{3} \right)}$$

The fault tolerant yield projection 199 shown in figure 5 is calculated according to this equation. It indicates that thoroughly implemented fault tolerance can increase wafer sort yield from under 1% to more than 90% under identical manufacturing conditions. This can reduce the manufacturing cost by a factor of 100.

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Total practical yield for this device at a defect density of 1 defect per square cm can be calculated as:

$$Y_{Total} = Y_{Fab} \times Y_{Sens} \times Y_{Test} = 90\% \times 90\% \times 95\% = 77\%$$

This is a practical total yield for volume production.

5 Printing System Embodiments

A schematic diagram of a digital electronic printing system using a print head of this invention is shown in Figure 6. This shows a monolithic printing head 50 printing an image 60 composed of a multitude of ink drops onto a recording medium 51. This medium will typically be paper, but can also be overhead transparency film, cloth, or many other substantially flat surfaces which will accept ink drops. The image to be printed is provided by an image source 52, which may be any image type which can be converted into a two dimensional array of pixels. Typical image sources are image scanners, digitally stored images, images encoded in a page description language (PDL) such as Adobe Postscript, Adobe Postscript level 2, or Hewlett-Packard PCL 5, page images generated by a procedure-call based rasterizer, such as Apple QuickDraw, Apple Quickdraw GX, or Microsoft GDI, or text in an electronic form such as ASCII. This image data is then converted by an image processing system 53 into a two dimensional array of pixels suitable for the particular printing system. This may be color or monochrome, and the data will typically have between 1 and 32 bits per pixel, depending upon the image source and the specifications of the printing system. The image processing system may be a raster image processor (RIP) if the source image is a page description, or may be a two dimensional image processing system if the source image is from a scanner.

If continuous tone images are required, then a halftoning system 54 is necessary. Suitable types of halftoning are based on *dispersed dot ordered dither* or *error diffusion*. Variations of these, commonly known as *stochastic screening* or *frequency modulation screening* are suitable. The halftoning system commonly used for offset printing - *clustered dot ordered dither* - is not recommended, as effective image resolution is unnecessarily wasted using this technique. The output of the

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halftoning system is a binary monochrome or color image at the resolution of the printing system according to the present invention.

The binary image is processed by a data phasing circuit 55 (which may be incorporated in a Head Control ASIC 400 as shown in figure 4) which 5 provides the pixel data in the correct sequence to the data shift registers 56. Data sequencing is required to compensate for the nozzle arrangement and the movement of the paper. When the data has been loaded into the shift registers 56, it is presented in parallel to the heater driver circuits 57. At the correct time, the driver circuits 57 will electronically connect the corresponding heaters 58 with the voltage 10 pulse generated by the pulse shaper circuit 61 and the voltage regulator 62. The heaters 58 heat the tip of the nozzles 59, affecting the physical characteristics of the ink. Ink drops 60 escape from the nozzles in a pattern which corresponds to the digital impulses which have been applied to the heater driver circuits. The pressure of the ink in the ink reservoir 64 is regulated by the pressure regulator 63. Selected 15 drops of ink drops 60 are separated from the body of ink by the chosen drop separation means, and contact the recording medium 51. During printing, the recording medium 51 is continually moved relative to the print head 50 by the paper transport system 65. If the print head 50 is the full width of the print region of the recording medium 51, it is only necessary to move the recording medium 51 in one 20 direction, and the print head 50 can remain fixed. If a smaller print head 50 is used, it is necessary to implement a raster scan system. This is typically achieved by scanning the print head 50 along the short dimension of the recording medium 51, while moving the recording medium 51 along its long dimension.

Integrated Drive Circuitry

25 Figure 7 shows one preferred embodiment of the invention comprising a print head with integrated drive circuitry. This print head has 19,840 nozzles, which are connected using eight shift registers, each of which contains 2,480 drive modules 220. For simplicity of the drawing, only eight of the 2,480 drive modules 220 in each shift register are shown. Also, only four of the eight shift 30 registers are shown. The preferred circuit for integrated nozzle drivers on large

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print heads incorporates fault tolerance. This is omitted from this diagram for simplicity.

The clock generation module 230 generates a gated two phase clock for the shift registers. This gated two phase clock allows the elimination of the 5 parallel registers that would otherwise be required to hold the data constant during the heater enable pulse. The two clock phases allow the use of dynamic shift registers instead of static shift registers, further reducing the number of integrated transistors required for each nozzle driver.

10 The three EnPhase signals are the input of a three line to eight line decoder 260. The Eight outputs of the decoder 260 are connected to the enable controls of the drive modules 220. As each output of the decoder 260 drives 2,480 loads distributed over the length of the print head, the output transistors of the decoder must be either very large, or buffered multiple times, to obtain fast switching.

15 The inclusion of the decoder 260 reduces the number of external connections required to control which of the eight groups is activated from eight to four.

The print head has only a small number of connections. There are:

- 1) V_+ , which is the positive power connection to the heaters.
- 20 2) V_- , which is the return power (ground) connection to the heater drive transistors.
- 3) V_{ss} , which is the positive power connection to the shift registers and data enable circuits.
- 4) V_{ss} , which is the return power (ground) connection for the shift registers and data enable circuits.
- 25 5) Clock, which is the main system clock, used for clocking the shift registers.
- 6) EnPhase, which is firing phase enable selection.
- 7) Enable, which is a global enable signal. If this signal is inactive, no printing can occur.
- 30 8) Data<0-7>, which are the eight serial data input signals which control which nozzles are to be energized.

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9) Test, which is an Or function of the data at the output of the shift registers. The eight outputs are wired to the inputs of a eight input Or gate 270. This output can be used for testing the integrity of the shift registers in the print head. Only one shift register can be tested at a time. More sophisticated test circuitry can be included on the print head using well known techniques.

5 As with most manufactured products, the cost of manufacture is important. If the device costs too much to manufacture, it will not succeed commercially.

Block fault tolerance

10 The invention consists of block fault tolerance circuitry which corrects faults in the data transfer mechanisms of an integrated printing head comprising:

- 1) a plurality of data transfer mechanisms which, in the absence of faults, transfers data to the printing actuators;
- 15 2) one or more redundant data transfer mechanisms;
- 3) a means of determining which of the data transfer mechanisms contain faults;
- 4) a means of connecting the output of an operational data transfer mechanism, which precedes a faulty data transfer mechanism in terms of data flow, to the input of a redundant data transfer mechanism; and
- 20 5) a means of connecting the output of the redundant data transfer mechanism to the input of the data transfer mechanism which normally is connected to the output of the faulty data transfer mechanism in terms of data flow.

The invention is applicable to many types of printing mechanisms which consist of a plurality of dot marking means integrated into a single structure.

25 Examples of such printing mechanisms include, but are not limited to, coincident forces drop on demand printing heads, thermal ink jet print heads, thermal wax printer heads, dye sublimation print heads, and thermal paper print heads.

The table "LIFT head type A4-4-600" (see Appendix A) is a summary of some characteristics of an example full color monolithic printing head 30 capable of printing an color A4 page at 600 dpi in approximately one second.

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Block fault tolerance implementation

Figure 8 shows a block diagram of a system implementing block fault tolerance in the data distribution system of a print head with integrated drive circuitry.

5 In this example, the data distribution mechanisms are shift registers. There are as many shift registers operating in parallel as there are operational phases of the print head. This is indicated by the number n , which in the example of a high speed full color print head is eight. Each stage of each shift register provides parallel data to a printer actuator driver.

10 The shift registers are divided into segments 241. Individual segments 241 can be replaced by a redundant shift register segment of the same length 242. The number of segments m that each shift register is divided into is not critical. Decreasing the length of each segment results in a required increase in the number of segments for a given number of actuators in the print head. This 15 increases the number of multiplexers required on the chip, and therefore the redundancy overhead. However, it also decreases the number of actuators that are de-activated by the fault, and therefore increases the probability that a fault in the shift register can be compensated for by redundant actuator circuits.

20 For the example high speed color print head, each shift register contains 2,480 stages. These can be divided into 38 segments, each containing 64 shift register stages, with a 39th segment containing 48 shift register stages. By this means, a single fault in a shift register can affect a maximum of 64 actuators, instead of 2,480 actuators. Many other configurations are possible. As in this example, the shift register segments can be of differing lengths, so the number of segments that a 25 shift register is divided into does not need to be a factor of the number of stages in the shift register.

30 All of the actuators which are driven by the faulty shift register segment should also be disabled. This can be simply achieved by gating the enable pulse for the appropriate actuator drivers. This is done to simplify the redundancy circuit which replaces the faulty actuators. If all of the actuators in a faulty segment are deactivated, there is no requirement to determine the actual shift register stage

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in a segment which is faulty. All of the actuators in a segment are replaced by the redundancy circuit. Also, if the shift register fault is 'stuck active', then disabling the actuator drivers for the section of shift register prevents spurious dots from being printed. The same signal that is used to control the multiplexer 244 to select 5 the redundant shift register segment 242 can be used to disable the actuators controlled by the faulty shift register segment.

The redundant shift register 242 does not directly control any printer actuators. The redundant shift register simply maintains the overall shift register lengths, therefore resulting in the correct data being applied to shift registers 10 segments 241 subsequent to the faulty shift register segment. The replacement of the dot printing function of the actuators controlled by the faulty shift register segment is performed by redundancy circuitry disclosed in an Australian patent specification lodged concurrently herewith entitled 'Nozzle duplication for fault tolerance in integrated printing heads'.

15 Figure 9 discloses a block diagram of a system employing redundant actuators. Under normal operation, the image data 281 controls the drive circuit 282 which energizes the normally active (main) printing actuators 283. The main printing actuators are energized with electrical pulses which are timed so that the recording medium is marked in the correct positions corresponding to the image 20 data as the printing head containing the printing actuators scans the recording medium.

At various times, certain printing actuators may become faulty. These are detected by the fault detection unit 289. The design of the fault detection unit depends upon the circumstance in which the faults must be detected. Three 25 major categories for fault detection are:

1) After fabrication of the printing head. In this case, printing heads can be tested by especially constructed equipment which detects the presence of marks on a recording medium, or directly detects the presence of the ink or other marking material as it leaves the printing actuator. Such equipment may detect the 30 marking material optically, electrically, or by other means.

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- 2) After installation of the printing head in equipment containing drive circuitry and image generation circuitry, but before this equipment leaves the factory which manufactures the equipment. In this case, special test equipment can also be used. The cost of this equipment is not tightly constrained, as very few
5 pieces of such equipment would be required. This allows many different methods of detection to be used. One appropriate method is to cause the print head to print a particular pattern of dots, which includes dots printed by all of the printing actuators. The medium upon which these dots are recorded can then be scanned and analyzed by digital electronic equipment for the presence of
10 dots from each printing actuator. If the dots from a particular printing actuator are missing, then that printing actuator is recorded as being faulty.
- 3) During use of the equipment containing the printing head by the 'end user'. In this case, the cost of the fault detection equipment is important. If the equipment is a photocopier, it will typically include a scanner and a
15 microprocessor. In this case, one possible method is to print a test page which includes dots printed by all of the printing actuators. This page can then be scanned by the user in a special 'calibration' operating mode. The microprocessor then analyses the scanned data and calculates a 'map' of faulty printing actuators. If the unit is a printer, it will typically not incorporate a
20 scanner. In this case, the printer may include a single photodetector which is scanned across the printed test page while in 'calibration' mode. Using this technique, a low cost detector can be constructed.

A 'map' of faulty actuators is stored in the faulty actuator memory
288. A simple method is to use one bit of information to store the status of each
25 actuator. In the example printing head, 19,840 bits (2,480 bytes) are required to independently store the status of each main nozzle. This amount of memory can readily be provided using semiconductor memory of various types. It is convenient to store the fault map in a semiconductor memory which will not lose data when the power is turned off. Suitable memory devices are EEPROMs, EPROMs, battery-
30 backed SRAMs, or FLASH memory devices. Other device types may also be used.

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The 'map' of faulty printing actuators is used to control a gating circuit 284 which suppressed print data which is directed to functional main printing actuators, and allows print data directed towards faulty printing actuators to pass to the redundant printing actuators. The timing of the print data is adjusted by a timing 5 adjustment circuit 285 so that a dot printed by the redundant printing actuator will be at the same location as the dot would have been had it been printed by the main printing actuator. In the printing head example described herein, the timing adjustment is a delay of two line periods.

10 The timing adjusted image data for the redundant printing actuators controls the drive circuit 286 which energizes the redundant printing actuators 287.

A faulty shift register segment is detected by applying data at the 15 inputs of the shift register segments 241, and detecting the data at the outputs of the shift register segments. If the shift register segment is operational, the data at the output should be identical to the input data after a number of clock cycles equal to the segment length. The outputs of the shift register segments can be determined by 20 routing the appropriate output to a test circuit by controlling the multiplexers 243 and 245. The test function will typically be performed by an external microprocessor, but may be an on chip test circuit. The test function may also be provided by test equipment during wafer probe. However, if this latter method is 25 used in exclusion, fabrication faults can be corrected, but field failures cannot be corrected.

If a faulty shift register segment is found, the multiplexer select 30 control circuitry 246 is programmed to control the appropriate multiplexer 243 to select the output of the shift register segment 241, the output of which is normally connected to the input of the faulty shift register segment, as the input of the redundant shift register segment 242. The multiplexer select control circuitry 246 is also programmed to control a multiplexer 244 which normally selects data from the faulty shift register segment to instead select the output of the redundant shift register segment, and connect the data to the input of the shift register segment subsequent (in terms of data flow) to the faulty shift register segment.

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The multiplexer select control circuitry 246 may be implemented in many different ways. One of the most flexible ways is to implement it as static registers which are programmed every time the head is tested by an external microprocessor. This would typically be every time that power is applied to the 5 unit, but could also be at other times, such as upon user request. To reduce wiring on the chip, the static registers should be distributed along the printing head near the multiplexers that they control.

Another possible implementation of the multiplexer select control circuitry 246 is as programmable fuses or anti-fuses. This will typically use less 10 gates on the chip, but will also usually require extra wafer processing steps.

The multiplexer select control circuitry 246 may also be implemented by laser programming of the print head during wafer probe. However, this requires extra processing steps during fabrication, and cannot easily be used to compensate for field failures.

15

The foregoing describes several preferred embodiments of the present invention. Modifications, obvious to those skilled in the art, can be made thereto without departing from the scope of the invention.

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Appendix A

Monolithic LIFT head type A4-4-600

This is a four color print head for A4 size printing. The print head is fixed, and is the full width of the A4 paper. Resolution is 600 dpi bi-level for medium quality output.

Basic specifications	Derivation
Resolution — 600 dpi	Specification
Print head length — 215 mm	Width of print area plus 5 mm
Print head width — 5 mm	Derived from physical and layout constraints of head
Ink colors — 4	CMYK
Page size — A4	Specification
Print area width — 210 mm	Pixels per line / Resolution
Print area length — 297 mm	Total length of active printing
Page printing time — 1.3 seconds	Derived from fluid dynamics, number of nozzles, etc.
Pages per minute — 45 ppm	Per head, for full page size
Recording medium speed — 22.0 cm/sec	$1/\text{resolution} \cdot \text{actuation period times phasers}$
Basic IC process — 1.5 μ m CMOS	Recommendation
Bitmap memory requirement — 16.6 MBytes	Memory required when compression is not used
Pixel spacing — 42.33 μ m	Reciprocal of resolution
Pixels per line — 4,960	Active nozzles / Number of colors
Lines per page — 7,015	Scan distance * resolution
Pixels per page — 34,794,400	Pixels per line * lines per page
Drops per page — 139,177,600	Pixels per page * simultaneous ink colors
Average data rate — 12.3 MByte/sec	Pixels per second * ink colors / 8 MBytes
Yield and cost	Derivation
Number of chips per head — 1	Recommendation
Wafer size — 300 mm (12")	Recommendation for full volume production
Chips per wafer — 36	From chip size and recommended wafer size
Print head chip area — 10.7 cm^2	Chip width * Length
Scan yield without fault tolerance — 0.87%	Using Murphy's method, defect density = 1 per cm^2
Sort yield with fault tolerance — 90%	See fault tolerant yield calculations ($D=1/\text{cm}^2$, $CF=2$)
Total yield with fault tolerance — 72%	Based on mature process yield of 80%
Functional print heads per month — 260,208	Assuming 10,000 wafer starts per month
Print head assembly cost — \$10	Estimate
Factory overhead per print head — \$13	Based on \$120m. cost for refurbished 1.5 μ m Fab line amortized over 5 years, plus \$16m. P.A. operating cost
Wafer cost per print head — \$23	Based on materials cost of \$600 per wafer
Approx. total print head cost — \$46	Sum of print head assembly, overhead, and wafer costs

Appendix A (cont'd.)

Monolithic LIFT head type A4-4-600	
Nozzle and actuation specifications	Derivation
Nozzle radius 14 μm	Specification
Number of actuation phases 8	Specification
Nozzles per phase 2,480	From page width, resolution and colors
Active nozzles per head 19,840	Actuation phases * nozzles per phase
Redundant nozzles per head 19,840	Same as active nozzles for 100% redundancy
Total nozzles per head 39,680	Active plus redundant nozzles
Drop rate per nozzle 5,208 Hz	$1/(\text{heater active period} * \text{number of phases})$
Heater radius 14.5 μm	From nozzle geometry and radius
Heater thin film resistivity 23 $\mu\Omega\text{cm}$	For heater formed from TaAl
Heater resistance 2,095 Ω	From heater dimensions and resistivity
Average heater pulse current 5.6 mA	From heater power and resistance
Heater active period 24 μs	From finite element simulations
Settling time between pulses 168 μs	Active period * (actuation phases - 1)
Clock pulses per line 2,834	Assuming multiple clocks and no transfer register
Clock frequency 14.8 MHz	From clock pulses per line, and lines per second
Drive transistor on resistance 42 Ω	From recommended device geometry
Average head drive voltage 12.0 V	Heater current * (heater + drive transistor resistance)
Drop selection temperature 75 °C	m.p. of surfactant sol or PIT of microemulsion
Heater peak temperature 120 °C	From finite element simulations
Ink specifications	Derivation
Basic ink carrier Water	Specification
Surfactant Arachidic acid	Suggested method of achieving temperature threshold
Ink drop volume 18 pl	From finite element simulations
Ink density 1.030 g/cm ³	Black ink density at 60 °C
Ink drop mass 18.5 ng	Ink drop volume * ink density
Ink specific heat capacity 4.21 J/Kg/°C	Ink carrier characteristic
Max. energy for self cooling 2.715 nJ/drop	Ink drop heat capacity * temperature increase
Ejection energy per drop 1.387 nJ	Energy applied to heater in finite element simulations
Energy to print full black page 221 J	Drop ejection energy * drops per page
Total ink per color per page 0.63 ml	Drops per page per color * drop volume
Maximum ink flow rate per color 0.47 ml/sec	Ink per color per page / page print time
Full black ink coverage 40.2 ml/m ²	Ink drop volume * colors * drops per square metre
Ejection ink surface tension 38.5 mN/m	Surface tension required for ejection
Ink pressure 5.5 kPa	$2 * \text{Ejection ink surface tension} / \text{nozzle radius}$
Ink column height 545 mm	Ink column height to achieve ink pressure

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I. Claim:

1. In an integrated printing head having a plurality of printing actuators, apparatus for correcting faults in the data transfer to such actuators, said apparatus comprising:
 - (a) a plurality of data transfer devices which, in the absence of faults, transfer data to the printing actuators;
 - (b) at least one redundant data transfer device;
 - (c) means for determining which of the data transfer device contain faults;
 - (d) means for connecting the output of an operational data transfer device which precedes such faulty data transfer device, in terms of data flow, to the input of a corresponding redundant data transfer device; and
 - (e) means for connecting the output of said corresponding redundant data transfer device to the input of the data transfer device which normally is connected to the output of said faulty data transfer device, in terms of data flow.
2. An apparatus as claimed in Claim 1 wherein said data transfer devices are shift registers.
3. An apparatus as claimed in Claim 1 wherein said redundant data transfer devices are shift registers
4. An apparatus as claimed in Claim 1 wherein said means for determining which of the data transfer devices contain faults including a test means for applying data to the inputs of the devices and means for determining if the same data appears at the outputs of the data transfer devices an appropriate number of clock cycles later.
5. An apparatus as claimed in Claim 4 wherein said test means comprises an external microprocessor.
6. An apparatus as claimed in Claim 4 wherein said test means comprises an n-chip test circuit.

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7. An apparatus as claimed in Claim 1 wherein said means for connecting the output of an operational data transfer device to the input of a redundant data transfer device is a multiplexer.

8. An apparatus as claimed in Claim 7 wherein said multiplexer is constructed to be programmed by an external microprocessor.

9. An apparatus as claimed in Claim 7 further comprising an on-chip test and repair circuit for programming said multiplexer.

10. An apparatus as claimed in Claim 1 wherein said means for connecting the output of an operational data transfer device to the input of a redundant data transfer device comprises an integrated fusible link.

11. An apparatus as claimed in Claim 1 wherein said means for connecting the output of said redundant data transfer device to the input of the data transfer device which normally is connected to the output of said faulty data transfer, in terms of data flow, is a multiplexer.

12. An apparatus as claimed in Claim 11 wherein said multiplexer is adapted for programming by an external microprocessor.

13. An apparatus as claimed in Claim 11 further comprising an on-chip test and repair circuit means for programming said multiplexer.

14. An apparatus as claimed in Claim 1 wherein said means for connecting the output of said redundant data transfer device to the input of the data transfer device which normally is connected to the output of said faulty data transfer device, in terms of data flow, is an integrated fusible link.

15. An apparatus as claimed in Claim 1 wherein the marking means of said integrated printing head is a thermal printing element.

16. An apparatus as claimed in Claim 1 wherein the marking means of said integrated printing head is a thermal ink jet nozzle.

17. An apparatus as claimed in Claim 1 wherein the marking means of said integrated printing head is a thermal wax printer actuator.

18. An apparatus as claimed in Claim 1 wherein the marking means of said integrated printing head is a dye sublimation printer actuator.

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19. An apparatus as claimed in Claim 1 wherein the marking means of said integrated printing head is a heater element that is part of a heater bar of a thermal paper printer.

20. The invention according to Claim 1 wherein said printhead comprises

- (a) a plurality of drop-emitter nozzles;
- (b) a body of ink associated with said nozzles;
- (c) pressure means for subjecting ink in said body of ink to a pressure of at least 2% above ambient pressure, at least during drop selection and separation;
- (d) drop selection means for selecting predetermined nozzles and generating a difference in meniscus position between ink in selected and non-selected nozzles; and
- (e) drop separating means for causing ink from selected nozzles to separate as drops from the body of ink, while allowing ink to be retained in non-selected nozzles.

21. The invention according to Claim 1 wherein said printhead comprises

- (a) a plurality of drop-emitter nozzles;
- (b) a body of ink associated with said nozzles;
- (c) drop selection means for selecting predetermined nozzles and generating a difference in meniscus position between ink in selected and non-selected nozzles; and
- (d) drop separating means for causing ink from selected nozzles to separate as drops from the body of ink, while allowing ink to be retained in non-selected nozzles, said drop selecting means being capable of producing said difference in meniscus position in the absence of said drop separation means.

22. The invention according to Claim 1 wherein said printhead comprises

- (a) a plurality of drop-emitter nozzles;

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(b) a body of ink associated with said nozzles, said ink exhibiting a surface tension decrease of at least 10 mN/m over a 30°C temperature range;

(c) drop selection means for selecting predetermined nozzles and generating a difference in meniscus position between ink in selected and non-selected nozzles; and

(d) drop separating means for causing ink from selected nozzles to separate as drops from the body of ink, while allowing ink to be retained in non-selected nozzles.

23. An apparatus which corrects faults in the data transfer mechanisms of an integrated printing head comprising:

(a) a plurality of groups of normal data transfer devices which, in the absence of faults, transfer data to the printing actuators;

(b) a plurality of redundant data transfer devices, with at least one redundant data transfer device for each group of normal data transfer devices, except for a last said group;

(c) a means for determining which of the data transfer devices within a group contain faults; and

(d) multiplexer means for each group, such multiplexer means having a number of inputs at least equal to the number of data transfer devices in its respective group, and being programmable to select the output of a data transfer device which would normally be connected to the input of said faulty data transfer device, and direct such output to the input of the redundant data transfer device for said group.

24. The invention defined in Claim 23 further comprising multiplexer means for each group for directing the output of the group redundant transfer device to the input of the transfer device downstream from such faulty device.

25. An apparatus as claimed in Claim 23 wherein said data transfer devices are shift registers.

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26. An apparatus as claimed in Claim 23 wherein said redundant data transfer devices are shift registers.

27. An apparatus as claimed in Claim 23 wherein the marking means of said integrated printing head is a thermal printing nozzle.

28. An apparatus as claimed in Claim 23 wherein the marking means of said integrated printing head is a thermal ink jet nozzle.

29. An apparatus as claimed in Claim 23 wherein the marking means of said integrated printing head is a thermal wax printer actuator.

30. An apparatus as claimed in Claim 23 wherein the marking means of said integrated printing head is a dye sublimation printer actuator.

31. An apparatus as claimed in Claim 23 wherein the marking means of said integrated printing head is a heater element that is part of a heater bar of a thermal paper printer.

32. The invention according to Claim 23 wherein said printhead comprises

(a) a plurality of drop-emitter nozzles;

(b) a body of ink associated with said nozzles;

(c) pressure means for subjecting ink in said body of ink to a pressure of at least 2% above ambient pressure, at least during drop selection and separation;

(d) drop selection means for selecting predetermined nozzles and generating a difference in meniscus position between ink in selected and non-selected nozzles; and

(e) drop separating means for causing ink from selected nozzles to separate as drops from the body of ink, while allowing ink to be retained in non-selected nozzles.

33. The invention according to Claim 23 wherein said printhead comprises

(a) a plurality of drop-emitter nozzles;

(b) a body of ink associated with said nozzles;

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(c) drop selection means for selecting predetermined nozzles and generating a difference in meniscus position between ink in selected and non-selected nozzles; and

(d) drop separating means for causing ink from selected nozzles to separate as drops from the body of ink, while allowing ink to be retained in non-selected nozzles, said drop selecting means being capable of producing said difference in miniscus position in the absence of said drop separation means.

34. The invention according to Claim 23 wherein said printhead comprises

(a) a plurality of drop-emitter nozzles;

(b) a body of ink associated with said nozzles, said ink exhibiting a surface tension decrease of at least 10 mN/m over a 30°C temperature range;

(c) drop selection means for selecting predetermined nozzles and generating a difference in meniscus position between ink in selected and non-selected nozzles; and

(d) drop separating means for causing ink from selected nozzles to separate as drops from the body of ink, while allowing ink to be retained in non-selected nozzles.

35. A fault tolerant printing system comprising:

(1) an integrated printing head having a plurality of normally active printing actuators and:

(a) a plurality of data transfer devices which, in the absence of faults, transfer data to the printing actuators;

(b) at least one redundant data transfer device;

(c) means for determining which of the data transfer device contain faults;

(d) means for connecting the output of an operational data transfer device which precedes such faulty data transfer

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device, in terms of data flow, to the input of a corresponding redundant data transfer device; and

(e) means for connecting the output of said corresponding redundant data transfer device to the input of the data transfer device which normally is connected to the output of said faulty data transfer device, in terms of data flow;

(2) means for signaling the identity of a normally and active printing actuator that is ineffective due to faulty data transfer;

(3) a plurality of redundant printing actuators having print capability correspondence to said normally active actuators; and

(4) means, responsive to said signaling means, for energizing a redundant printing actuator that corresponds the actuator ineffective due to faulty data transfer, to operate under control of data that normally would be transferred to said ineffective actuator.

36. The invention defined in Claim 35 wherein said redundant actuators are located in printing alignment, upstream or downstream, of their respective corresponding normally active actuators and further comprising control means to synchronize operation of the redundant actuators to print in proper spacial register.

37. The invention according to Claim 34 wherein said printhead comprises

(a) a plurality of drop-emitter nozzles;

(b) a body of ink associated with said nozzles;

(c) pressure means for subjecting ink in said body of ink to a pressure of at least 2% above ambient pressure, at least during drop selection and separation;

(d) drop selection means for selecting predetermined nozzles and generating a difference in meniscus position between ink in selected and non-selected nozzles; and

-74-

(e) drop separating means for causing ink from selected nozzles to separate as drops from the body of ink, while allowing ink to be retained in non-selected nozzles.

38. The invention according to Claim 34 wherein said printhead comprises

(a) a plurality of drop-emitter nozzles;

(b) a body of ink associated with said nozzles;

(c) drop selection means for selecting predetermined nozzles and generating a difference in meniscus position between ink in selected and non-selected nozzles; and

(d) drop separating means for causing ink from selected nozzles to separate as drops from the body of ink, while allowing ink to be retained in non-selected nozzles, said drop selecting means being capable of producing said difference in miniscus position in the absence of said drop separation means.

39. The invention according to Claim 34 wherein said printhead comprises

(a) a plurality of drop-emitter nozzles;

(b) a body of ink associated with said nozzles, said ink exhibiting a surface tension decrease of at least 10 mN/m over a 30°C temperature range;

(c) drop selection means for selecting predetermined nozzles and generating a difference in meniscus position between ink in selected and non-selected nozzles; and

(d) drop separating means for causing ink from selected nozzles to separate as drops from the body of ink, while allowing ink to be retained in non-selected nozzles.

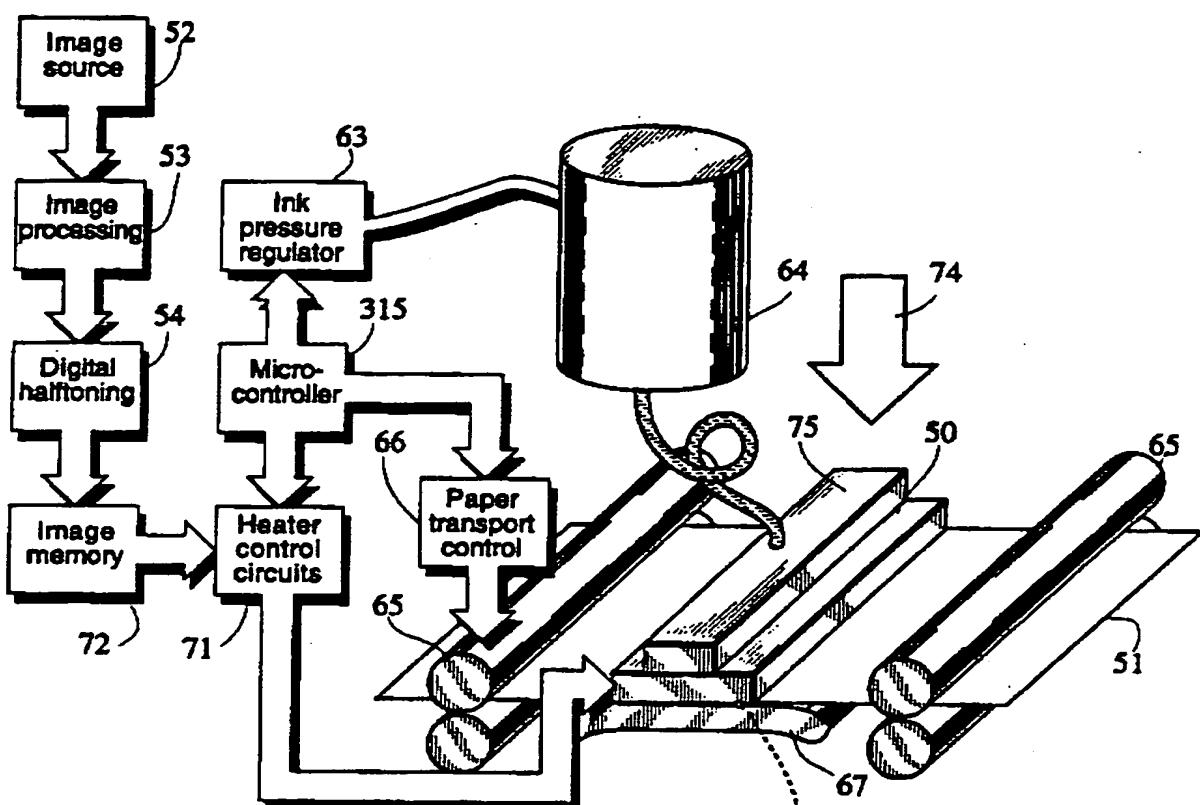


Fig 1(a)

- [Silicon] Silicon
- [Heater] Heater
- [Metal 1] Metal 1
- [Metal 2] Metal 2
- [Si₃N₄] Si₃N₄
- [SiO₂] SiO₂
- [SiO₂] SiO₂
- [Ink] Ink
- [Boron doped silicon] Boron doped silicon

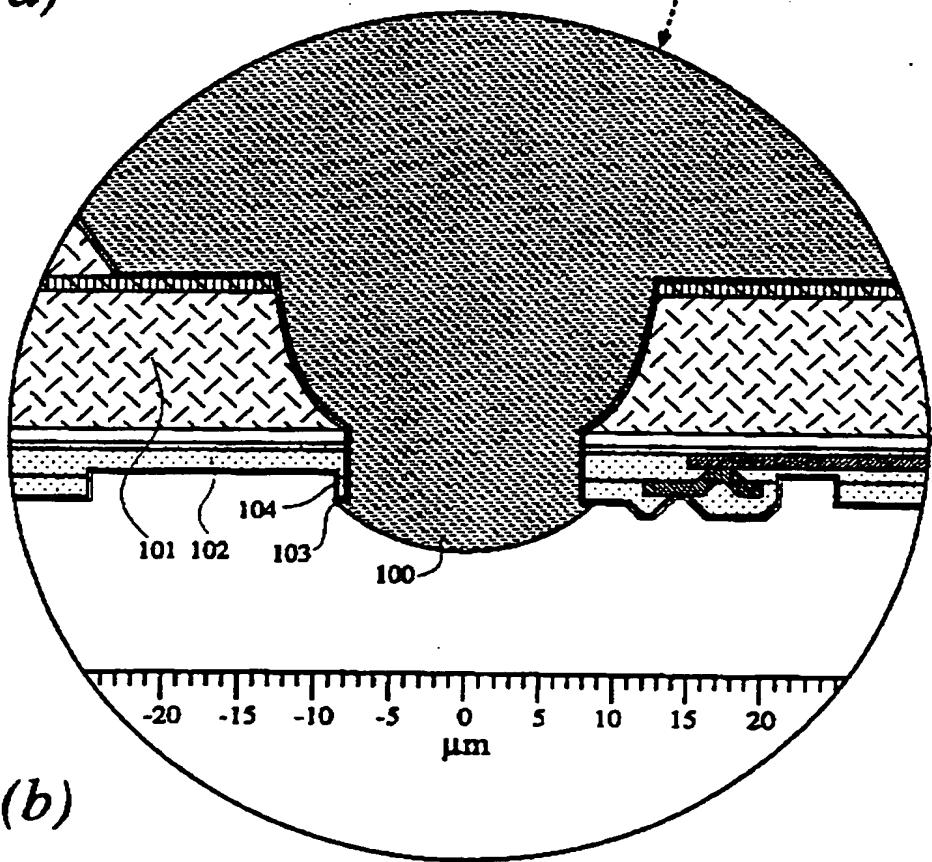


Fig 1(b)

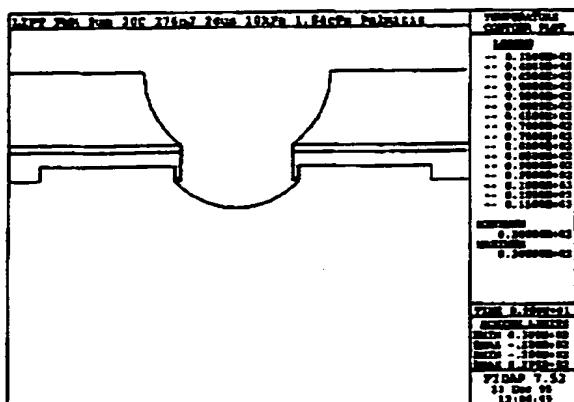


Fig 2(a)

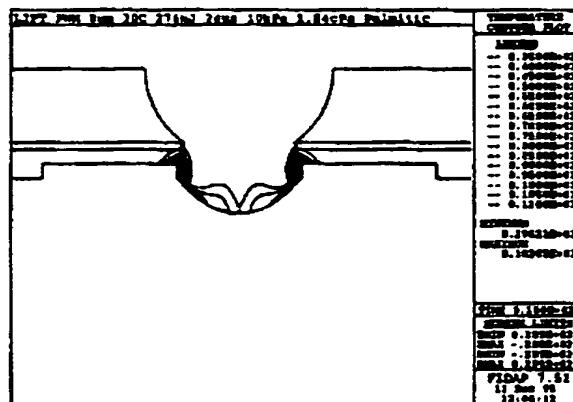


Fig 2(b)

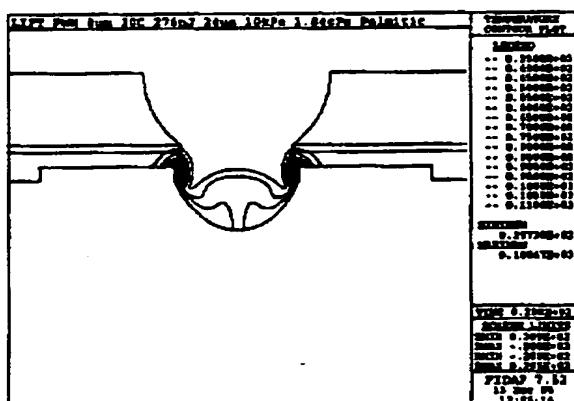


Fig 2(c)

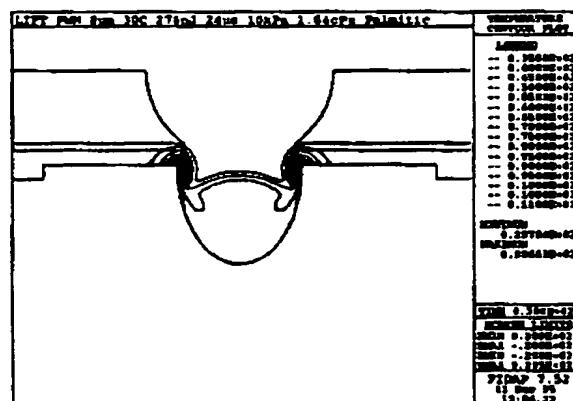


Fig 2(d)

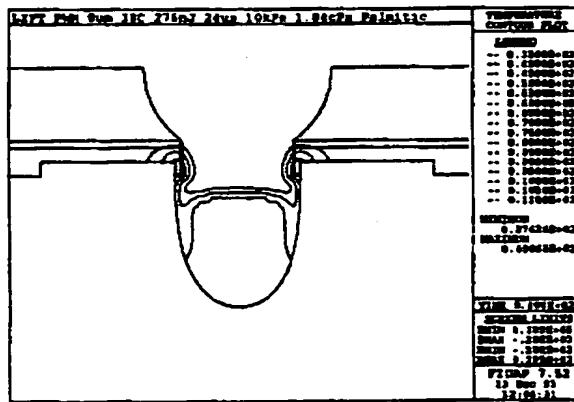


Fig 2(e)

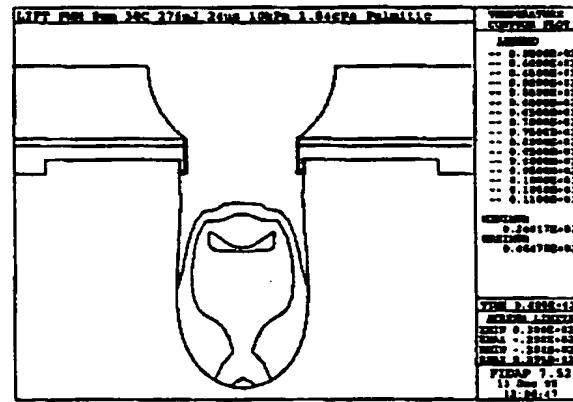


Fig 2(f)

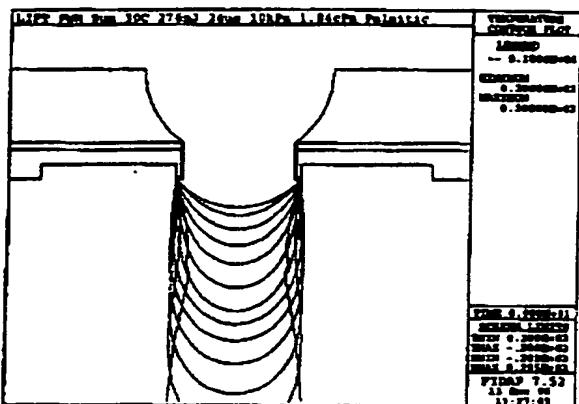


Fig 3(a)

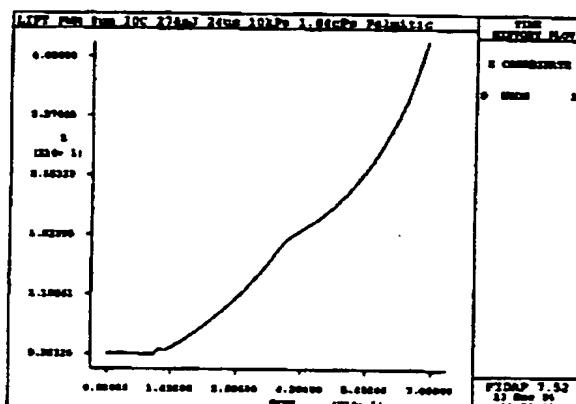


Fig 3(b)

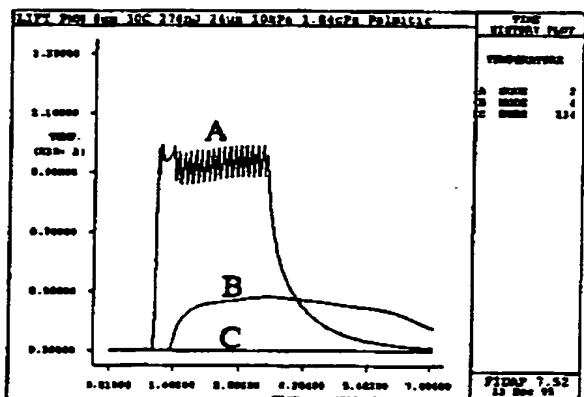


Fig 3(c)

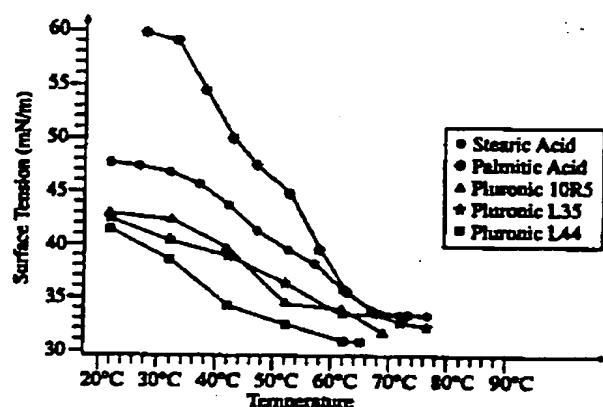


Fig 3(d)

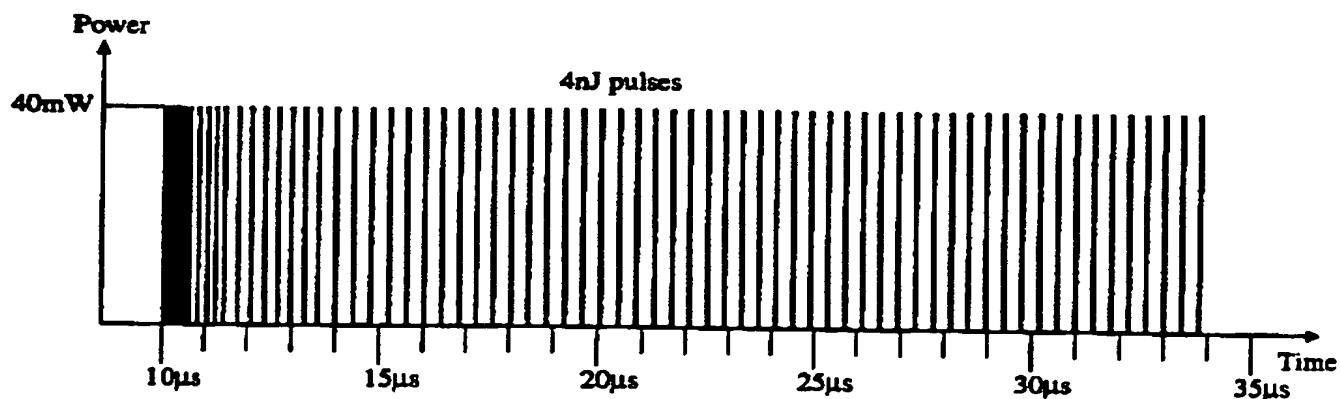
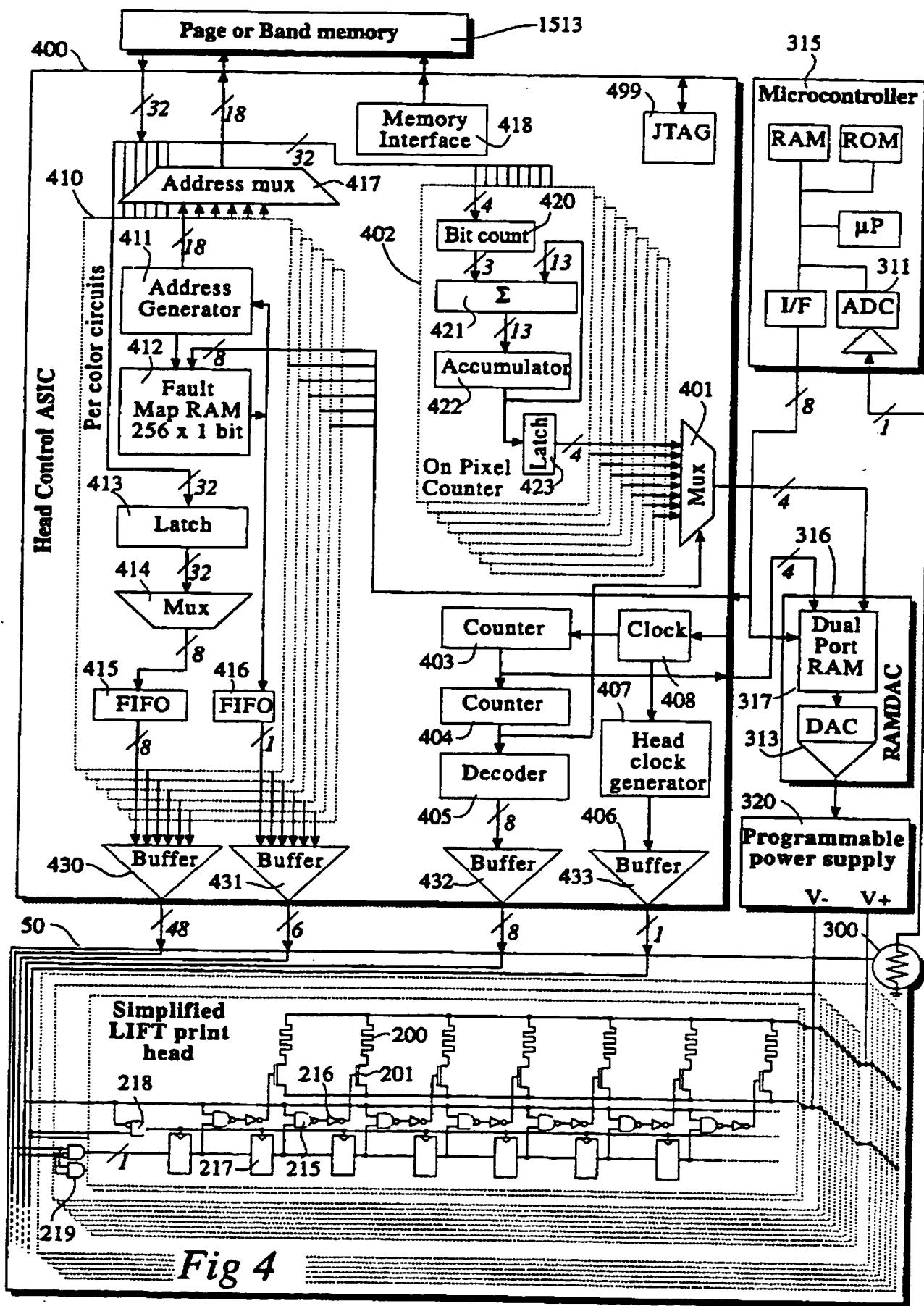
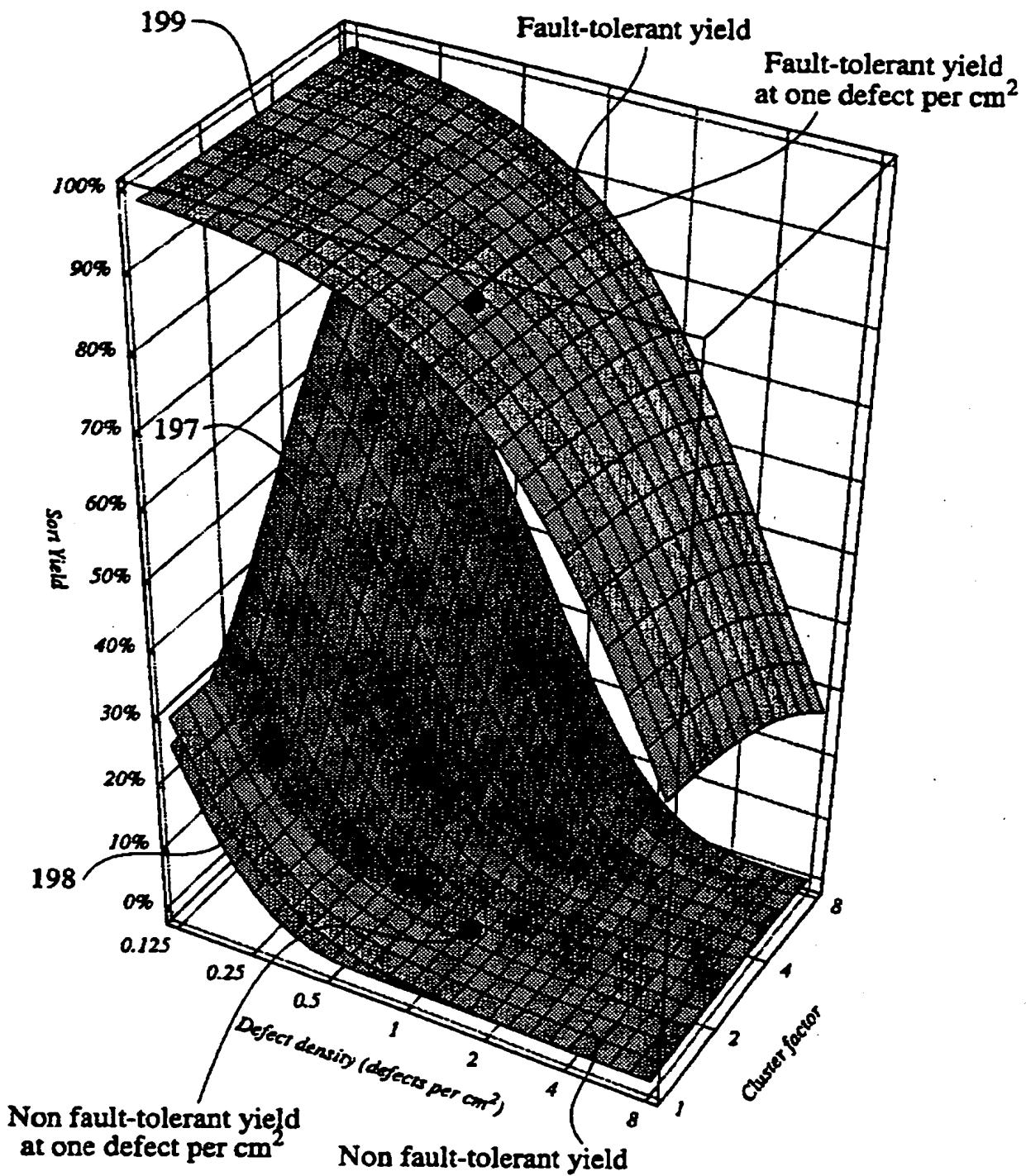


Fig 3(e)



Sort yield projection for LIFT head type A4-4-600**Fig 5**

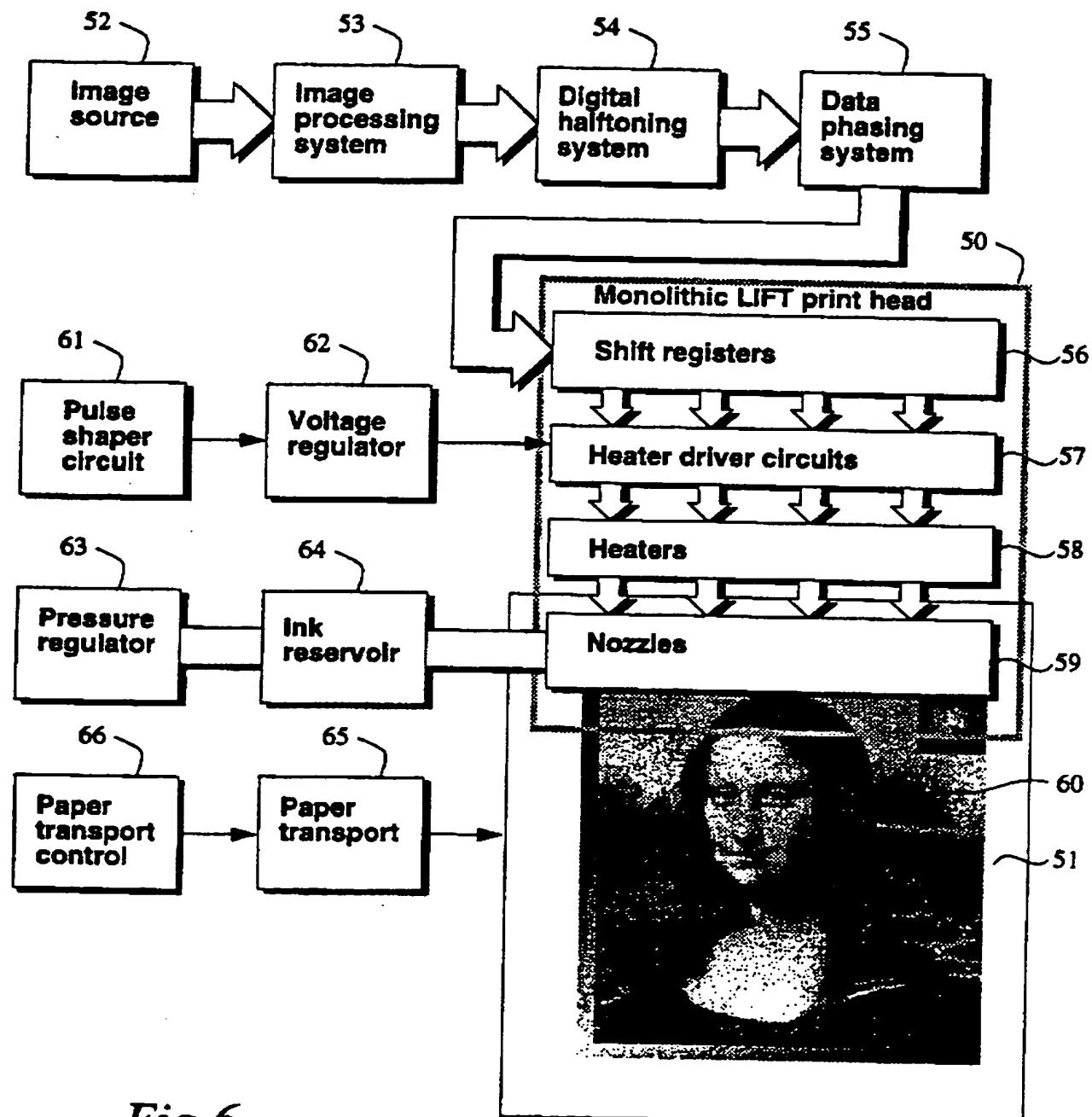
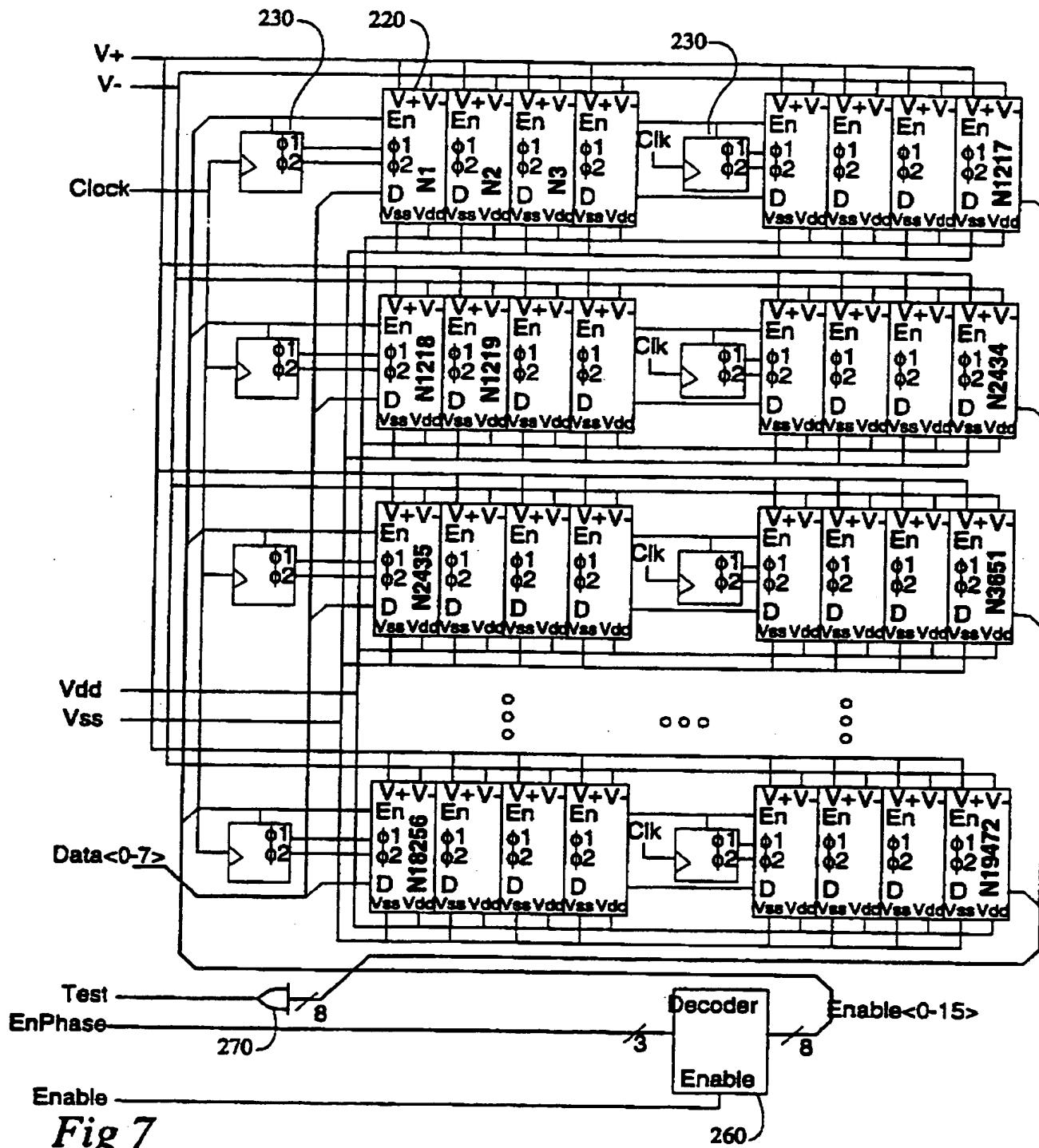


Fig 6



Enable

Fig 7

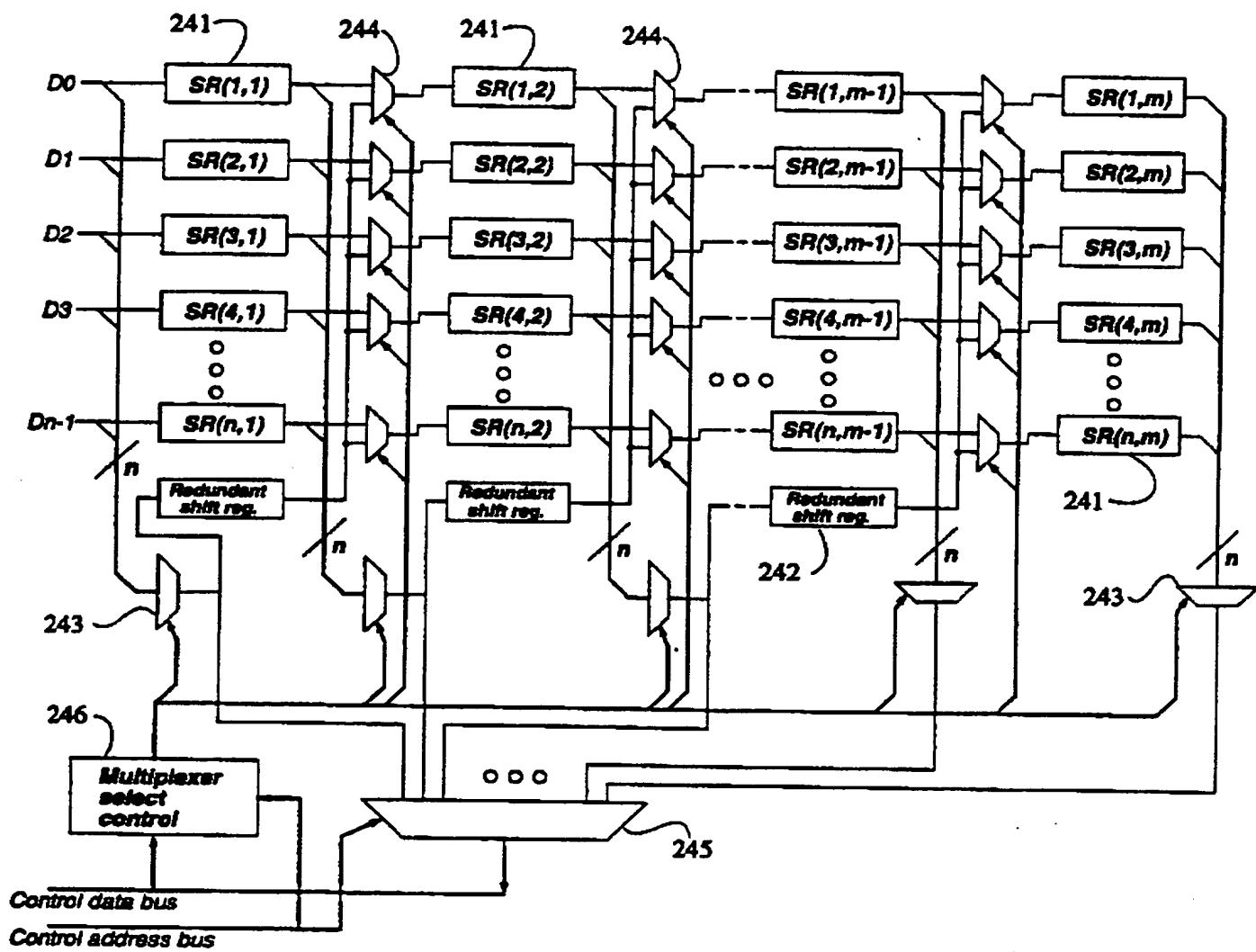


Fig 8

INTERNATIONAL SEARCH REPORT

International Application No
PCT/US 96/04896

A. CLASSIFICATION OF SUBJECT MATTER
IPC 6 B41J2/04 B41J2/14

According to International Patent Classification (IPC) or to both national classification and IPC

B. FIELDS SEARCHED

Minimum documentation searched (classification system followed by classification symbols)
IPC 6 B41J

Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched

Electronic data base consulted during the international search (name of data base and, where practical, search terms used)

C. DOCUMENTS CONSIDERED TO BE RELEVANT

Category *	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
X	EP,A,0 498 292 (CANON INFORMATION SYSTEMS) 12 August 1992 see page 18, line 28 - page 20, line 12; figures 58-67	1-3,16, 23
Y	see page 4, line 1 - line 3 ---	20-22, 32-39
Y	EP,A,0 600 712 (HEWLETT-PACKARD COMPANY) 8 June 1994 see the whole document ---	20-22, 32-39
Y	US,A,4 293 865 (JINNAI ET AL.) 6 October 1981 see the whole document ---	20-22, 32-39
		-/-

Further documents are listed in the continuation of box C.

Patent family members are listed in annex.

* Special categories of cited documents :

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- "T" later document published after the international filing date or priority date and not in conflict with the application but cited to understand the principle or theory underlying the invention
- "X" document of particular relevance; the claimed invention cannot be considered novel or cannot be considered to involve an inventive step when the document is taken alone
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- "Z" document member of the same patent family

1

Date of the actual completion of the international search	Date of mailing of the international search report
13 September 1996	27.09.96
Name and mailing address of the ISA European Patent Office, P.B. 5818 Patentlaan 2 NL - 2280 HV Rijswijk Tel: (+ 31-70) 340-2040, Tx: 31 651 epo nl, Fax: (+ 31-70) 340-3016	Authorized officer Meulemans, J-P

INTERNATIONAL SEARCH REPORT

International Application No
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C(Continuation) DOCUMENTS CONSIDERED TO BE RELEVANT

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Y	US,A,4 312 009 (LANGE) 19 January 1982 see the whole document ---	20-22, 32-39
Y	US,A,4 164 745 (CIELO ET AL.) 14 August 1979 see the whole document ---	20-22, 32-39
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Y	PATENT ABSTRACTS OF JAPAN vol. 010, no. 066 (M-461), 15 March 1986 & JP,A,60 210462 (FUJI XEROX KK), 22 October 1985, see abstract ---	20-22, 32-39
A	US,A,4 302 819 (WARE) 24 November 1981 see the whole document ---	1-39
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A	US,A,4 964 126 (MUSICUS ET AL.) 16 October 1990 see the whole document ---	1-39
A	US,A,4 281 398 (MCKENNY ET AL.) 28 July 1981 see the whole document ---	1-39
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International Application No

PCT/US 96/04896

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INTERNATIONAL SEARCH REPORT

Information on patent family members

Int'l and Application No

PCT/US 96/04896

Patent document cited in search report	Publication date	Patent family member(s)		Publication date
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		WO-A- 8102360	20-08-81	

INTERNATIONAL SEARCH REPORT

Inter. tel Application No.
PCT/US 96/04896

C(Cochrane) DOCUMENTS CONSIDERED TO BE RELEVANT

Category	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
A	<p>PATENT ABSTRACTS OF JAPAN vol. 018, no. 488 (E-1605), 12 September 1994 & JP,A,06 164810 (FUJITSU GENERAL LTD), 10 June 1994. see abstract</p> <p>-----</p>	1-39

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